



Electronics Systems (938II)

Lecture 3.4

Semiconductor Memories – Principles of Flash memory

Flash memory

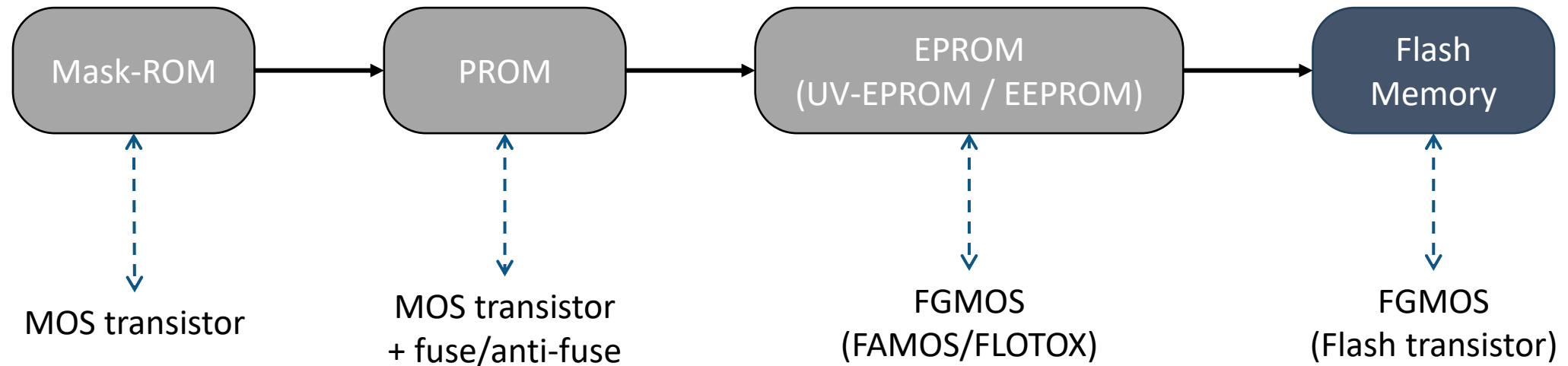
- It is the latest evolution of ROM
 - It is an evolution of EEPROM (by a technological point of view)
 - Same principle
 - MOS with a floating gate
 - Fully electrical: programming and erasing
 - But with some advantages
 - We will see it in detail later

Flash memory

- It is the latest evolution of ROM
 - Main application = non-volatile (massive) storage
 - Like a ROM
 - Yes, it can be “written” and “rewritten” (erasing + programming), also several times
 - But it cannot properly be considered an RWM
 - Because “writing” process is disruptive: it damages the device
 - Ideally, a RWM should be able to be written an infinite number of times, instead ...
 - Limited endurance (although very high)

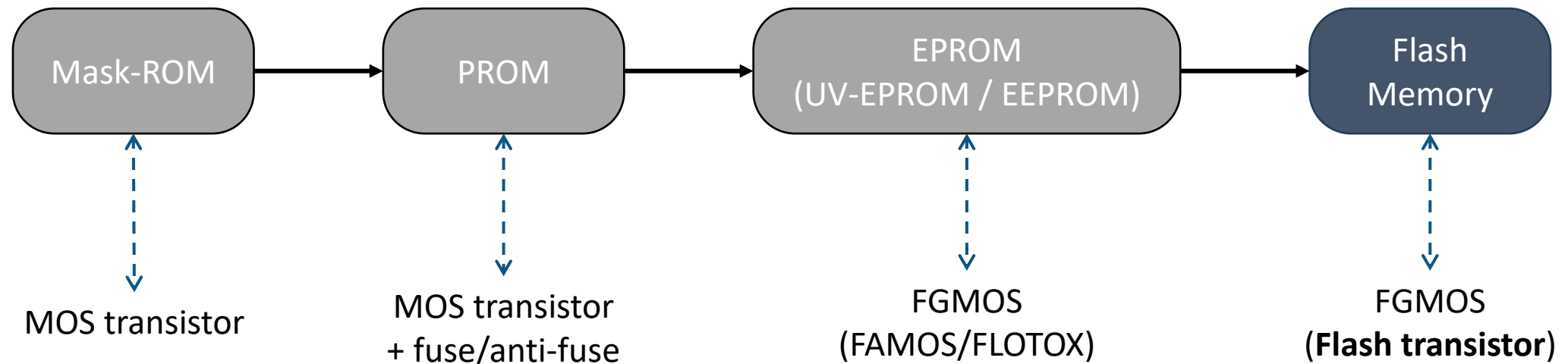
Flash memory

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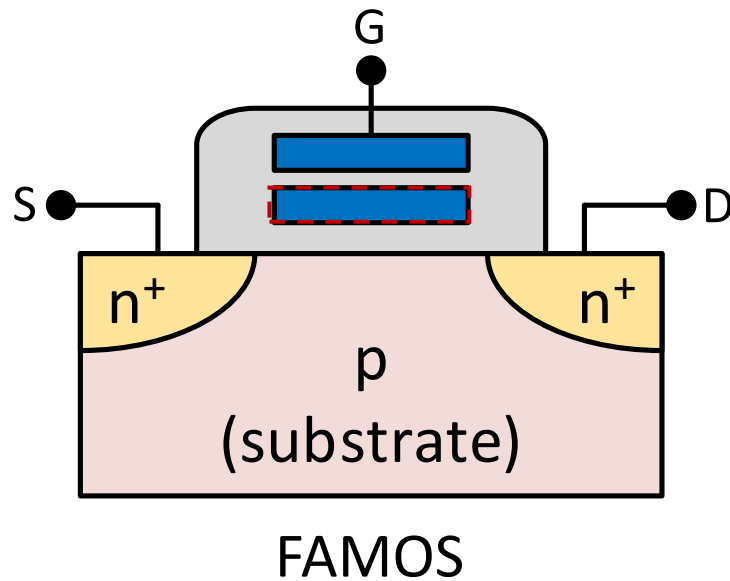
Flash memory

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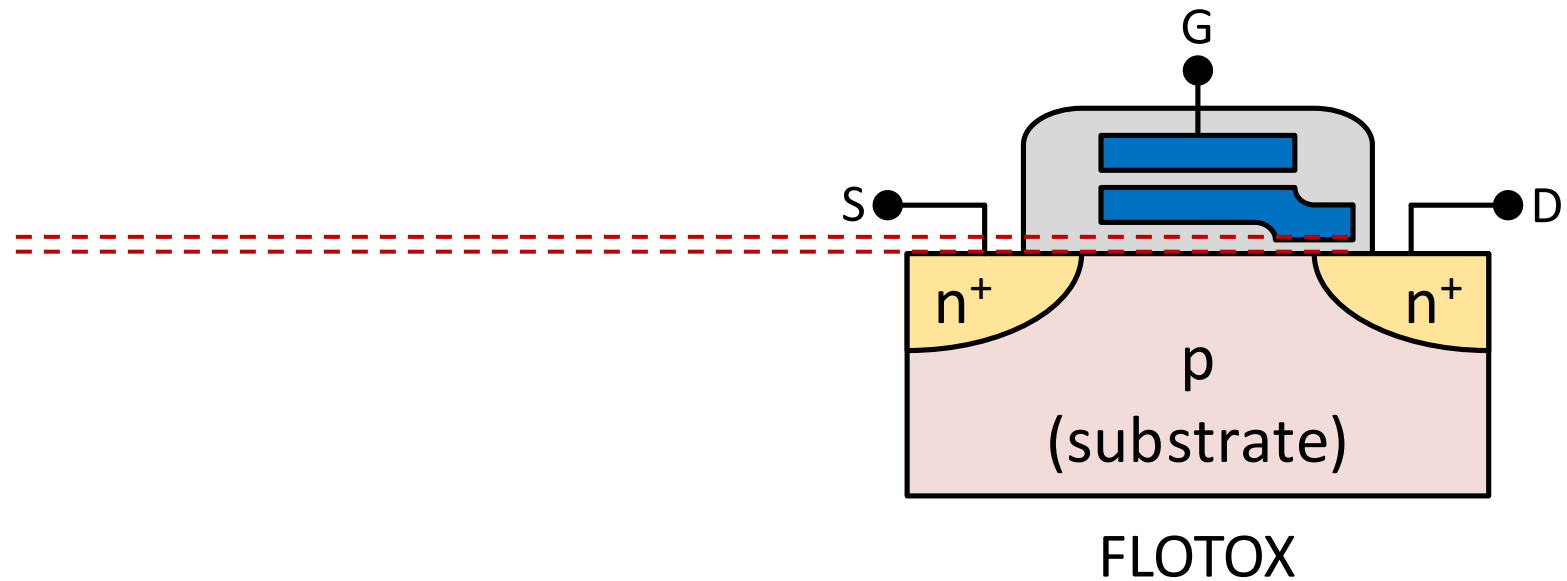
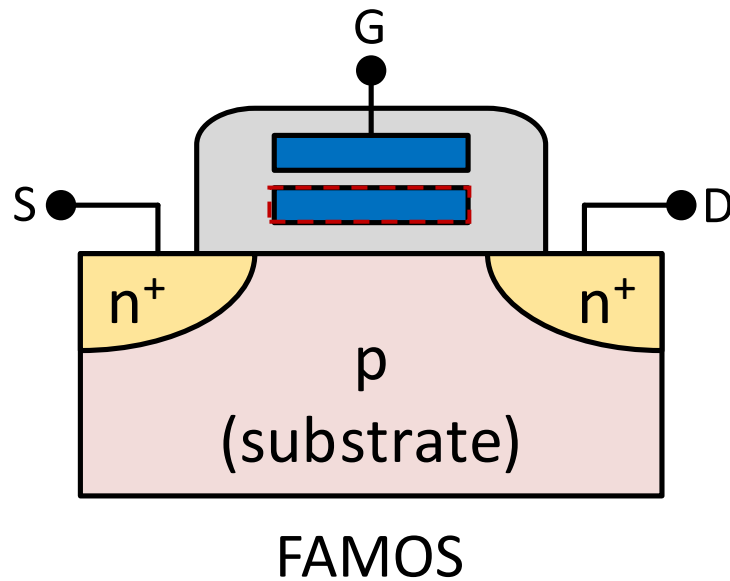
Flash transistor

- Another FGMOS
 - Merging characteristics of FAMOS and FLOTOX
 1. Symmetric floating gate



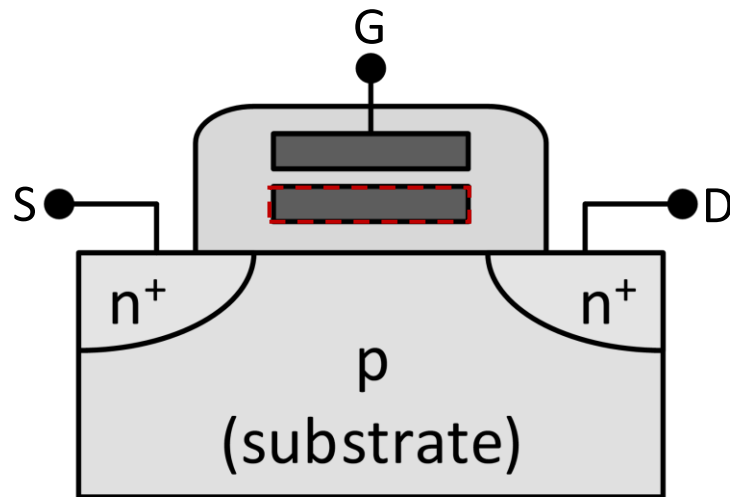
Flash transistor

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 - Merging characteristics of FAMOS and FLOTOX
 1. Symmetric floating gate
 2. Separated by a very thin oxide layer (from substrate)

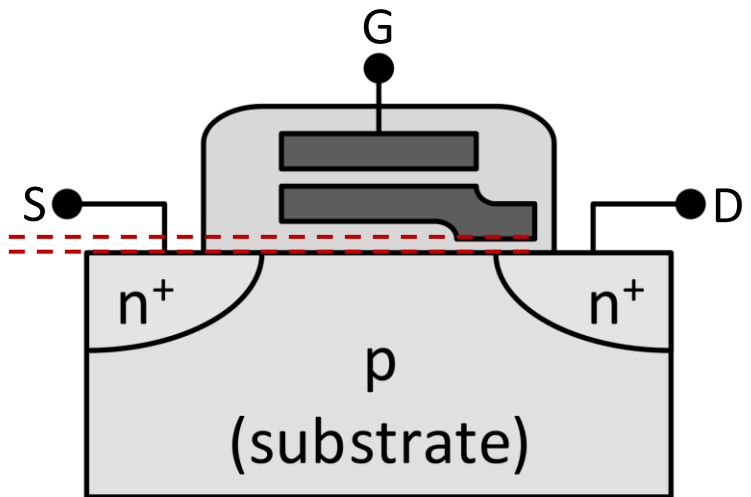
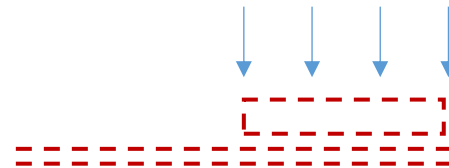


Flash transistor

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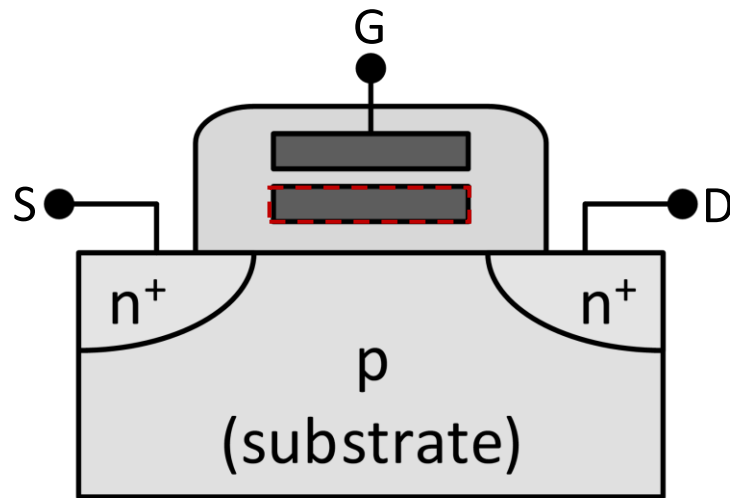
FAMOS



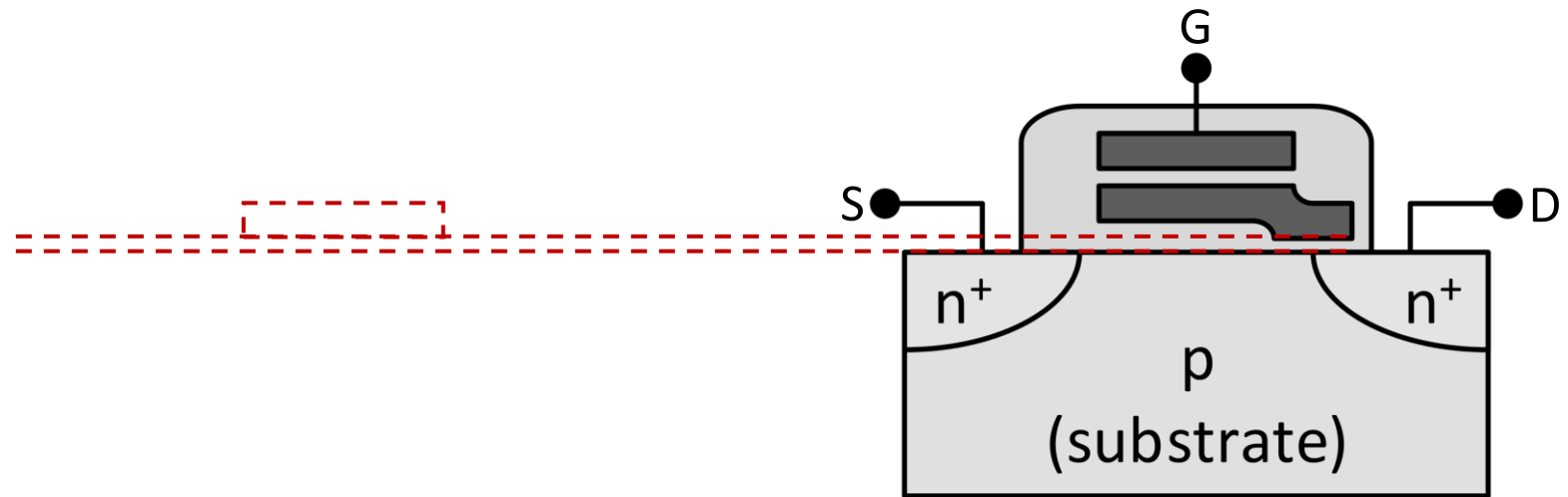
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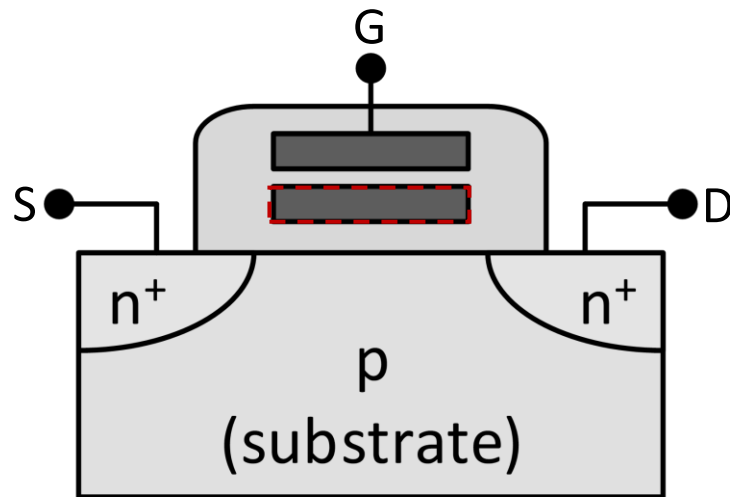
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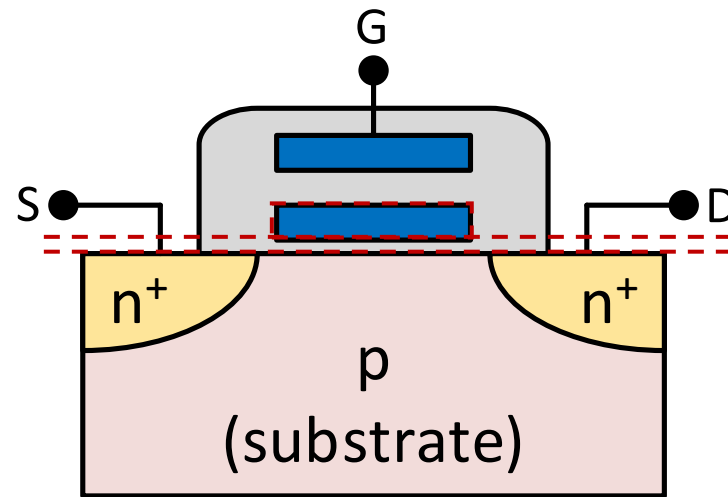
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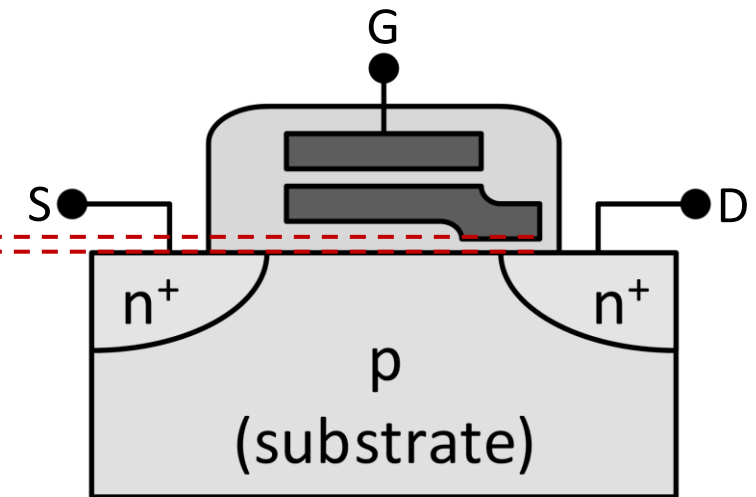
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FAMOS



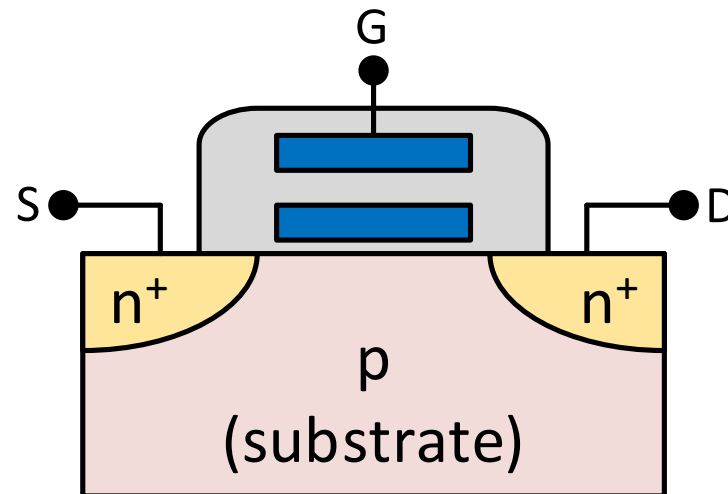
Flash



FLOTOX

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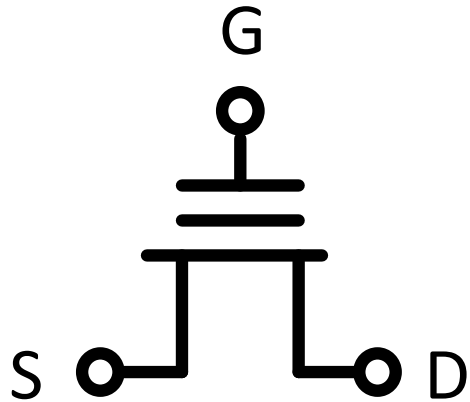
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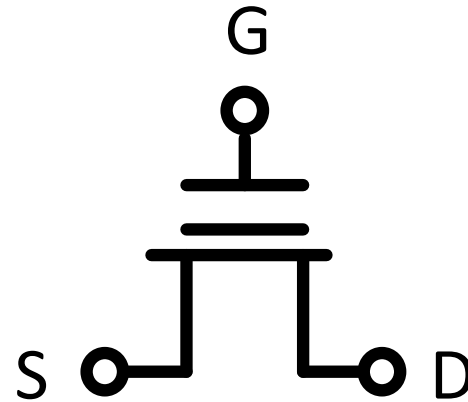
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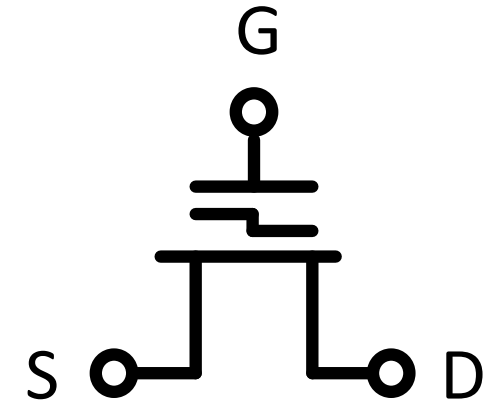
- Another FGMOS
 - Symbol



FAMOS



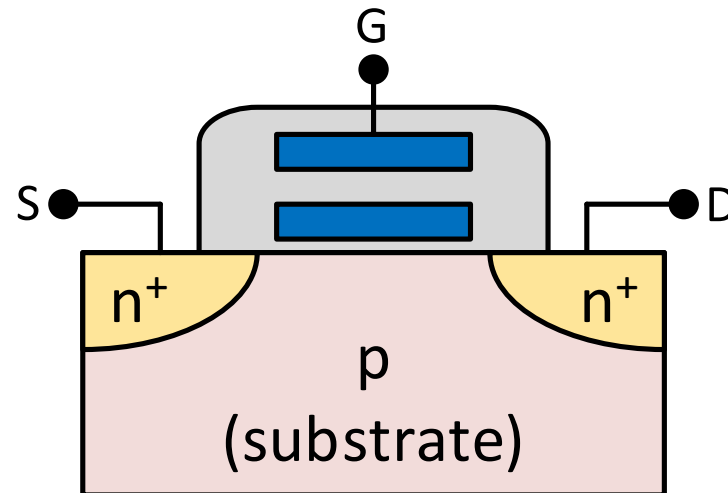
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Flash transistor

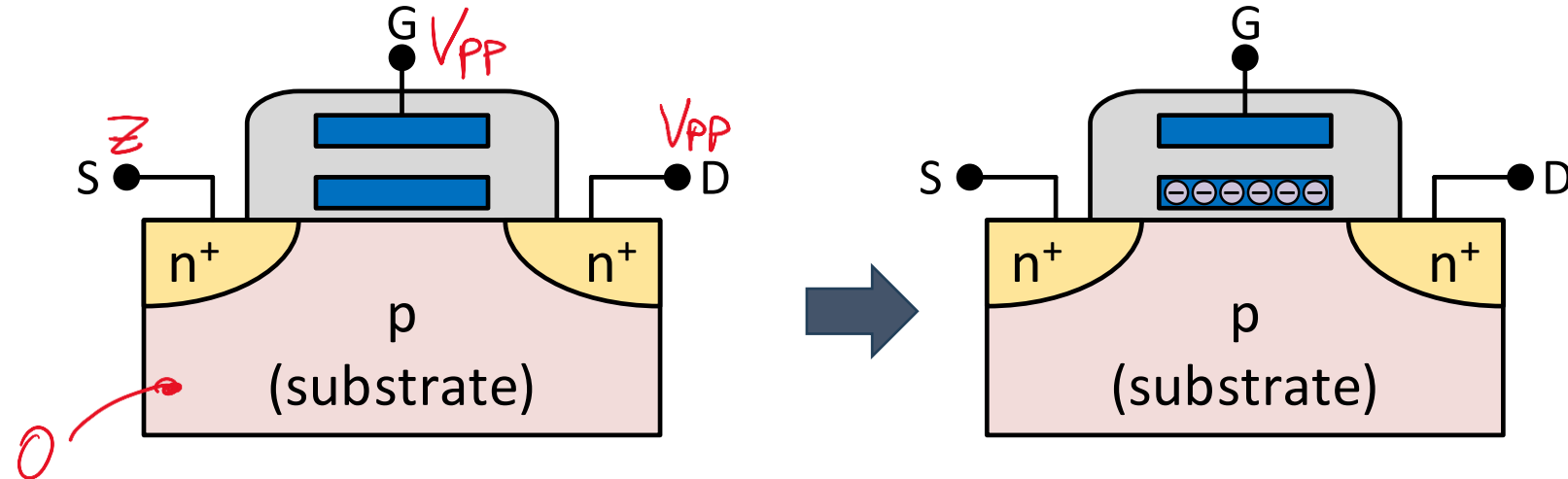
- Another FGMOS
 - Both programming and erasing depend on the tunnel effect (like FLOTOX), but
 - Using substrate: V_{sub}
 - Programming similar to FAMOS (using also Drain)!



Flash transistor

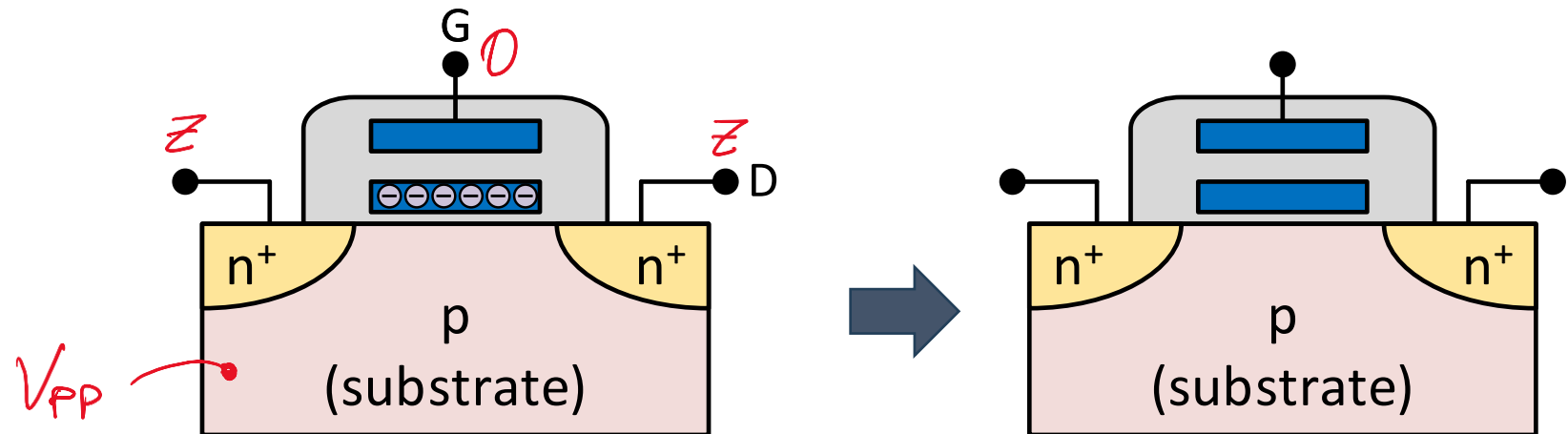
• Programming

- $V_G = V_D = V_{PP}$
 - like FAMOS
- $V_{sub} = 0$
- $V_S = Z$



• Erasing

- $V_G = 0$
- $V_{sub} = V_{PP}$
- $V_S = V_D = Z$



Flash memory

- Two main categories
 - Changing how (flash) transistors are connected to the Word Lines and Bit Lines

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Type of Flash Memory	NAND
Cost per bit (density)	Low (High)
Erase speed	High
Write speed	High
Supporting random read	No (organized in blocks)
Data retention	Medium (10 years)
Endurance	High
Application	Data storage

Flash memory

- Two main categories
 - Changing how (flash) transistors are connected to the Word Lines and Bit Lines

Type of Flash Memory	NAND	NOR
Cost per bit (density)	Low (High)	High (Low)
Erase speed	High	Low (about 150 times slower)
Write speed	High	Low
Supporting random read	No (organized in blocks)	Yes
Data retention	Medium (10 years)	High (20 years)
Endurance	High	Low
Application	Data storage	Code storage and execution

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- Two main categories
 - Changing how (flash) transistors are connected to the Word Lines and Bit Lines

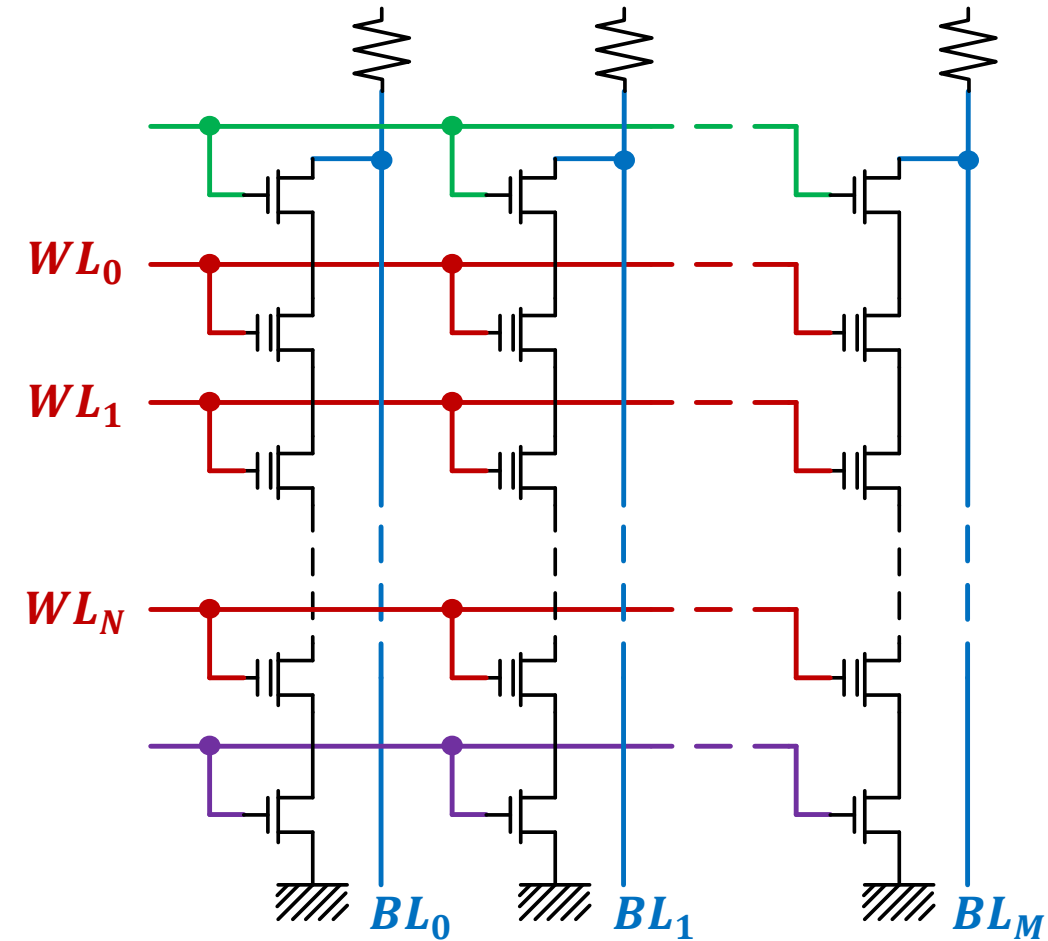
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USB drives and SSDs!!!



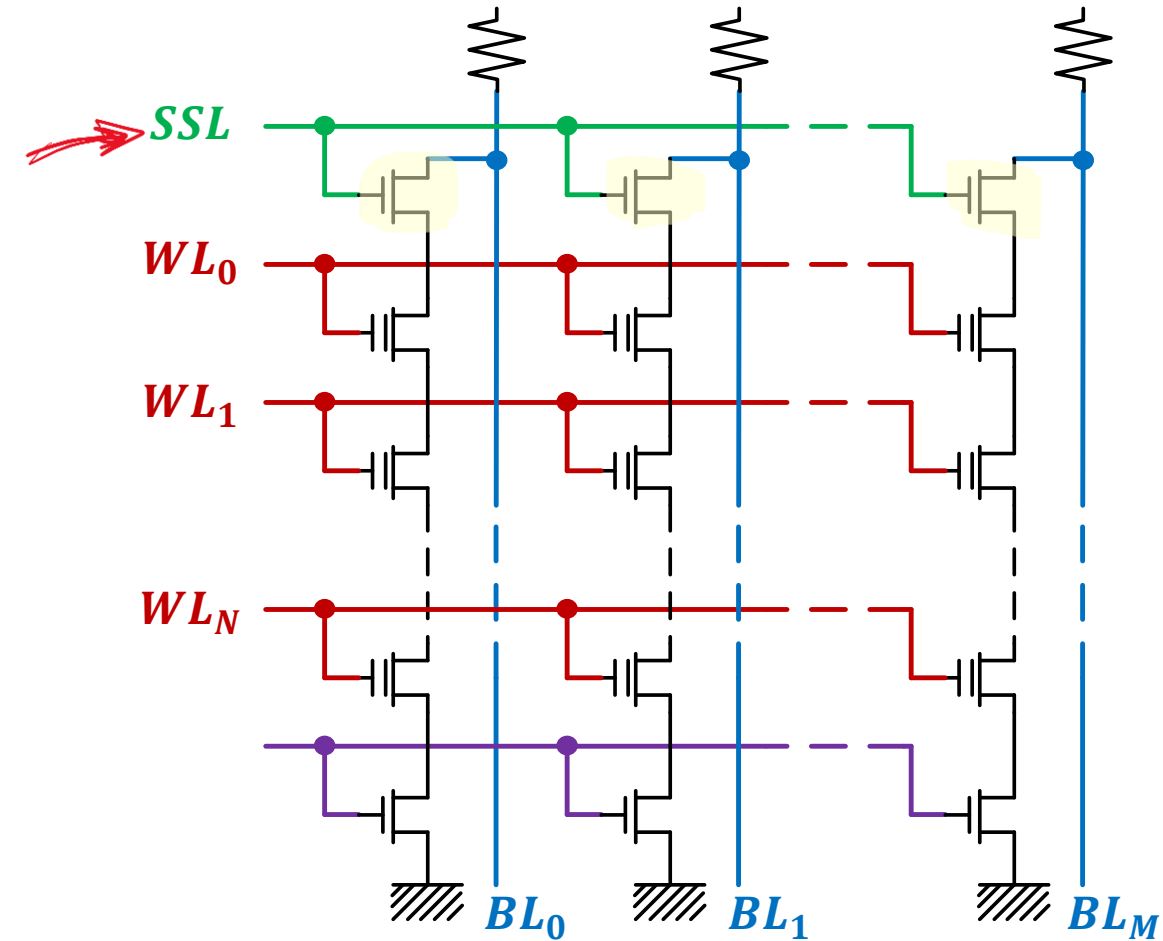
(NAND) Flash memory

- Architecture outline
 - WL_i and BL_j well known



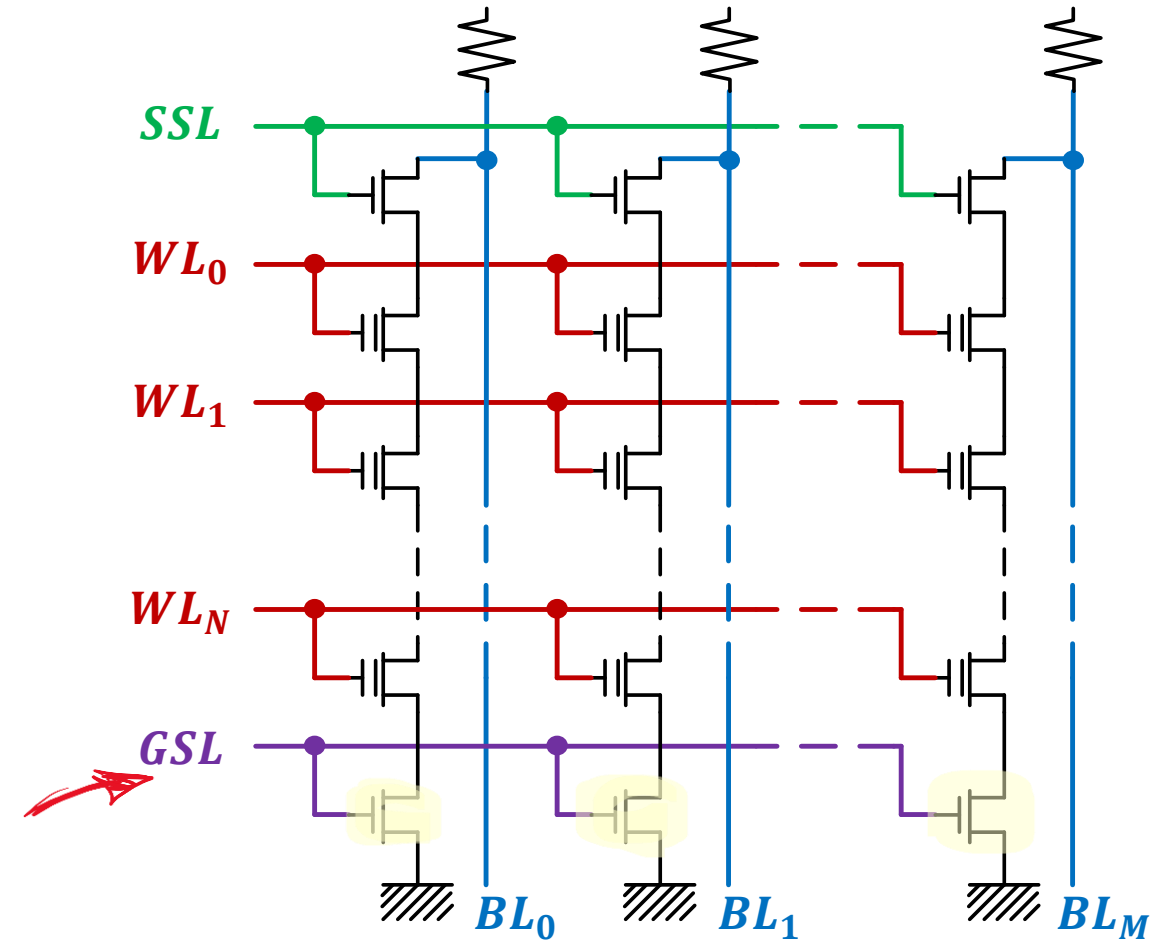
(NAND) Flash memory

- Architecture outline
 - SSL = String Select Line
 - Driving pass transistors (n-MOS)



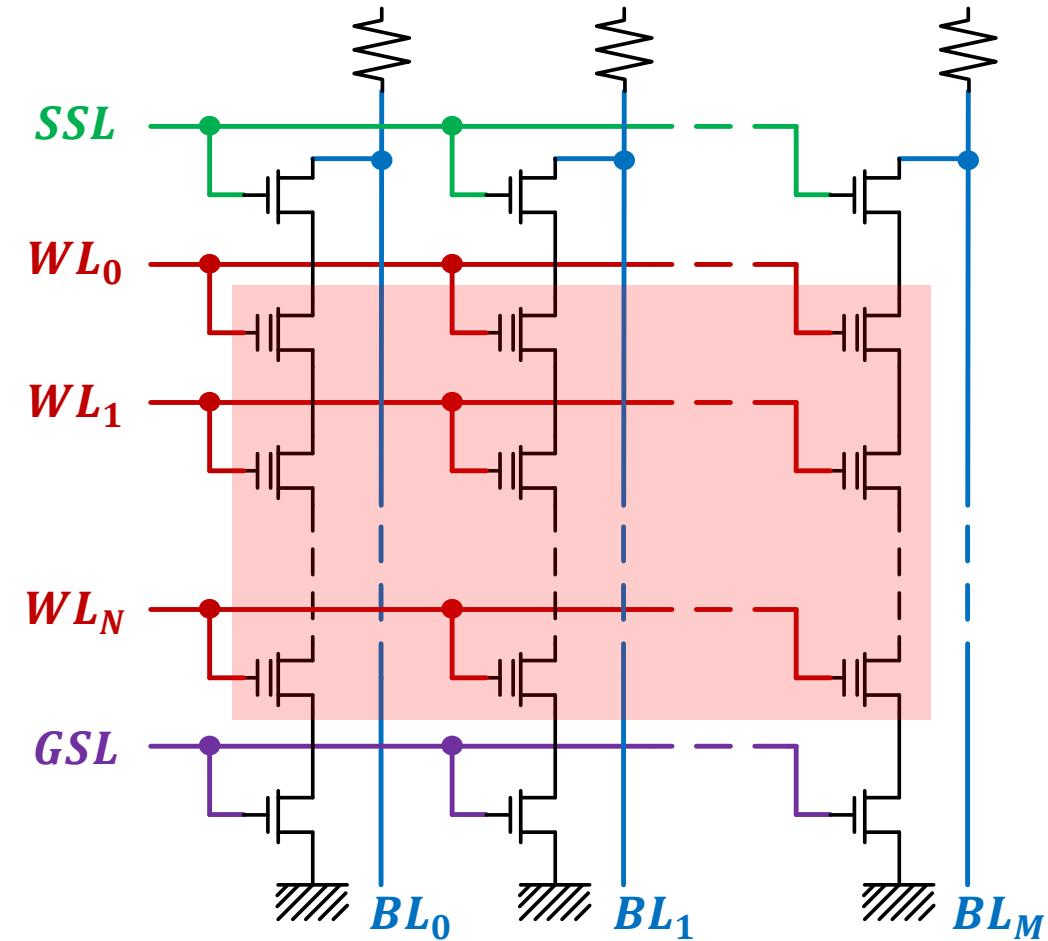
(NAND) Flash memory

- Architecture outline
 - GSL = Ground Select Line
 - Driving pass transistors (n-MOS)



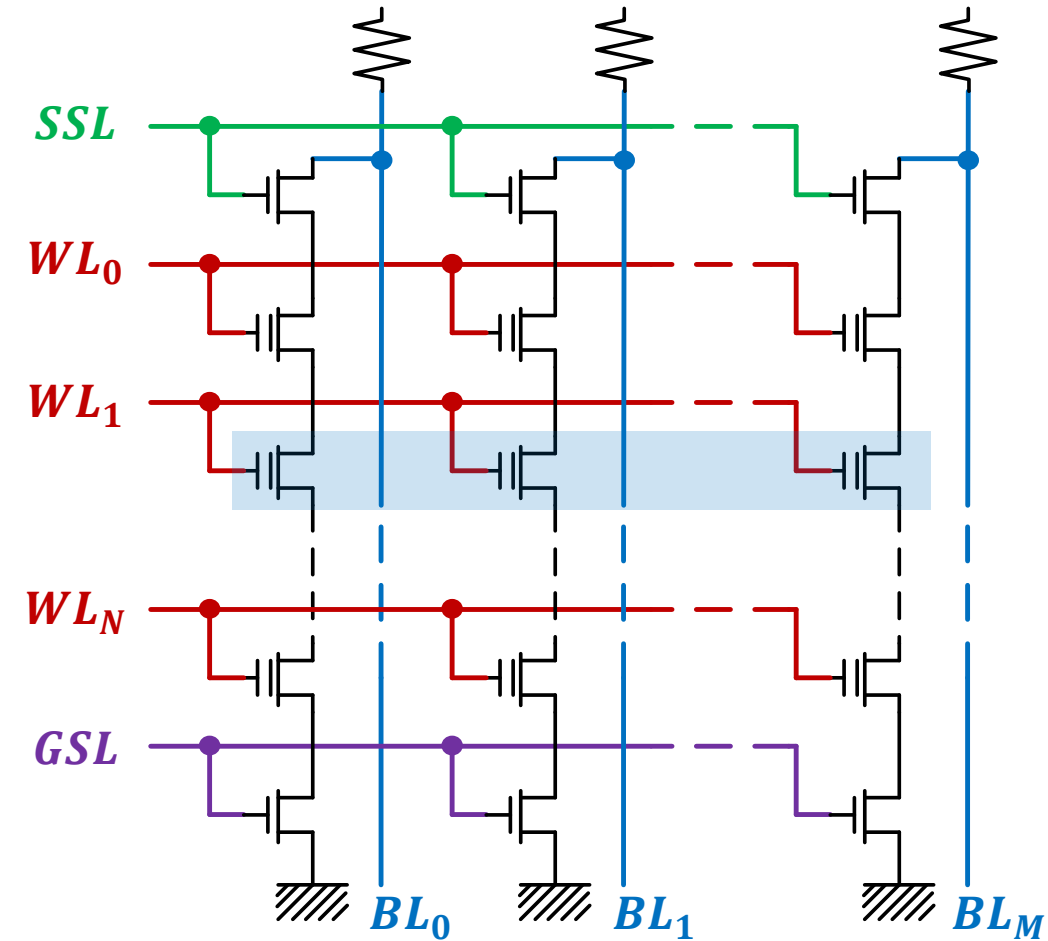
(NAND) Flash memory

- Architecture outline
 - Block
 - All the Flash transistors/memory cells
 - Sharing substrate!!!



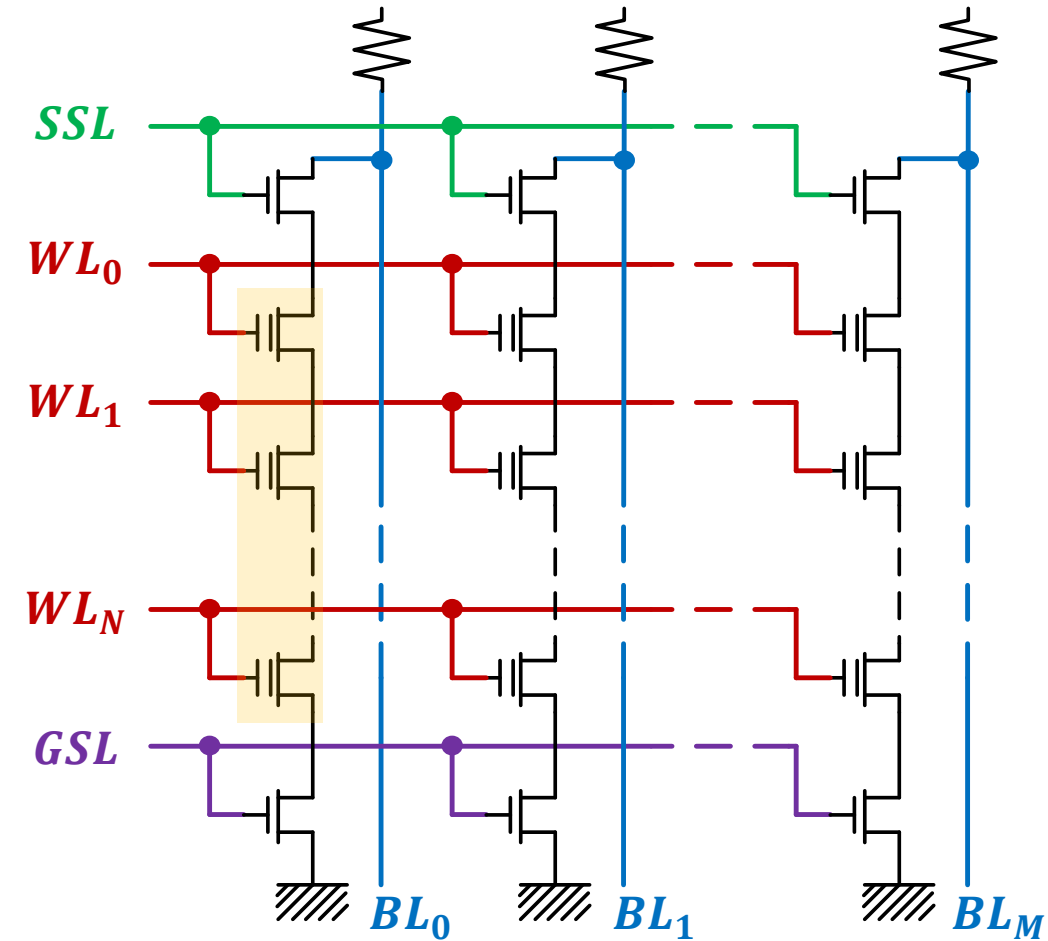
(NAND) Flash memory

- Architecture outline
 - Page



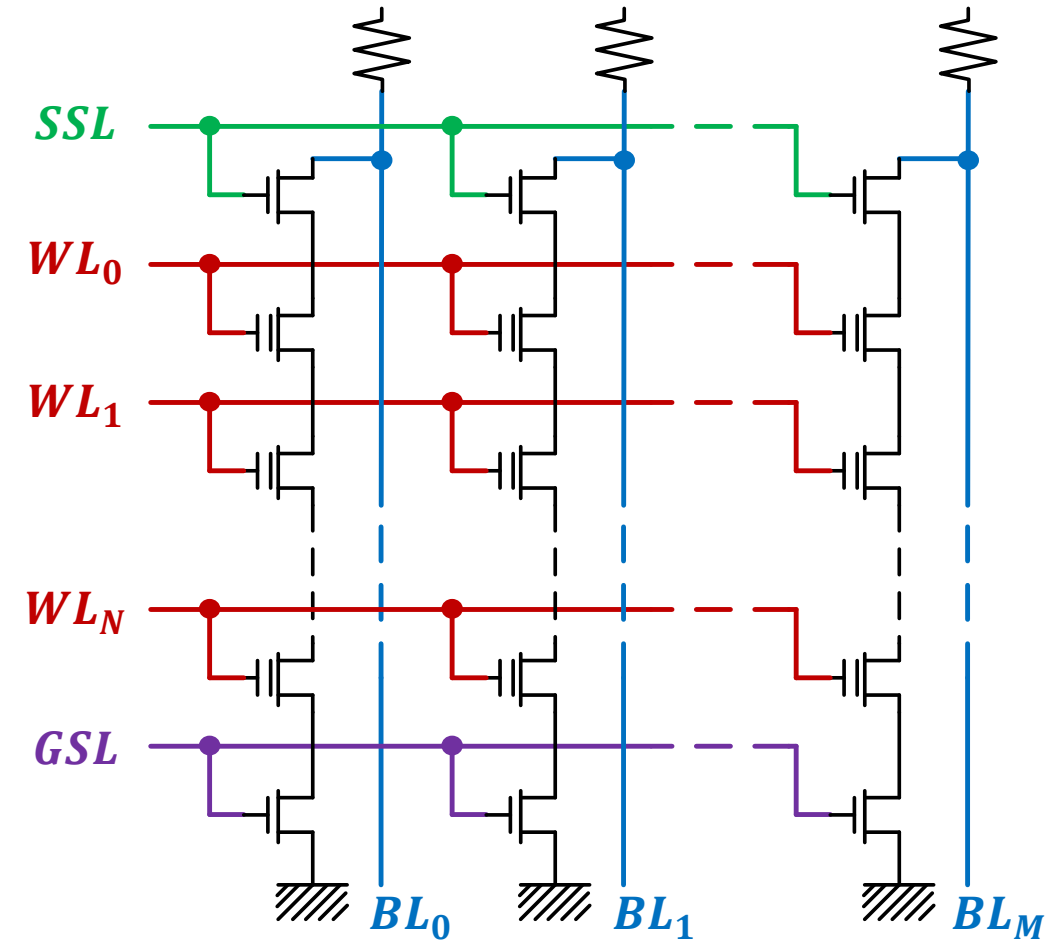
(NAND) Flash memory

- Architecture outline
 - String
 - $[32 \div 128]$ transistors



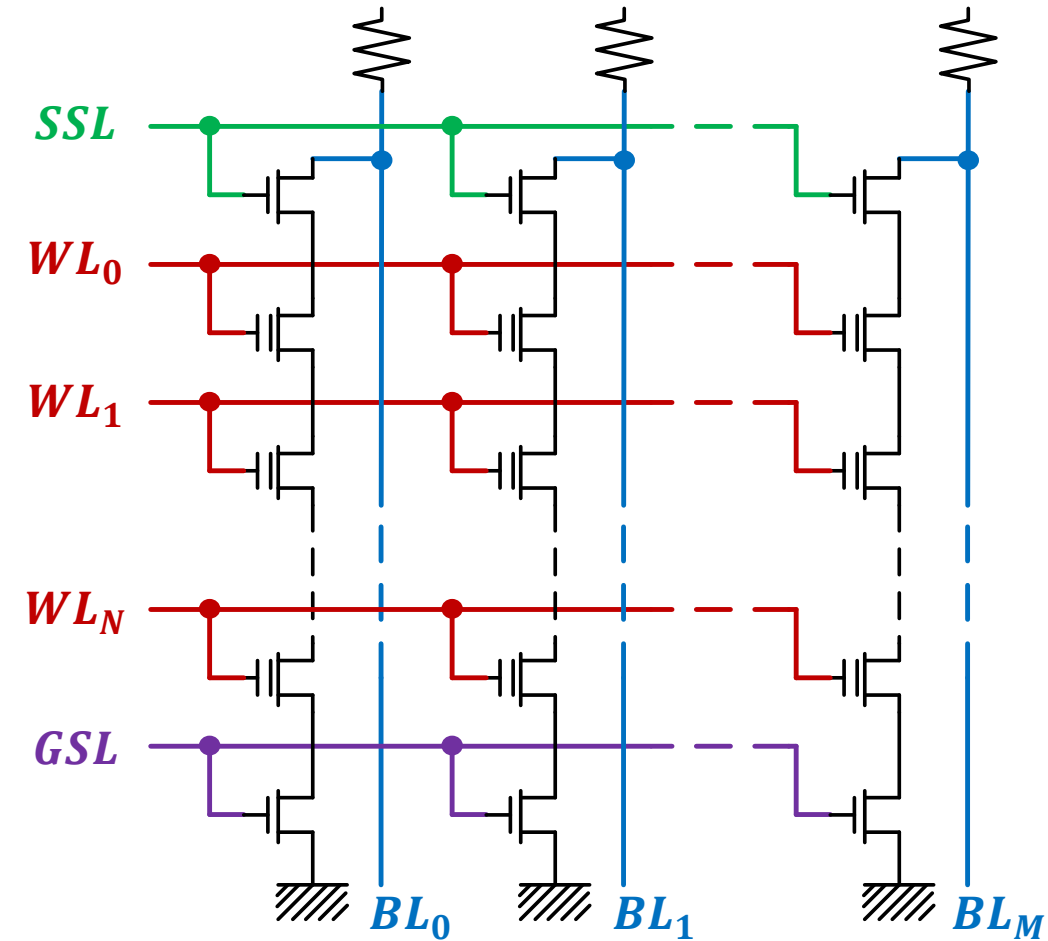
(NAND) Flash memory

- Working principle
 - Read by page
 - Program by page
 - Erase by block



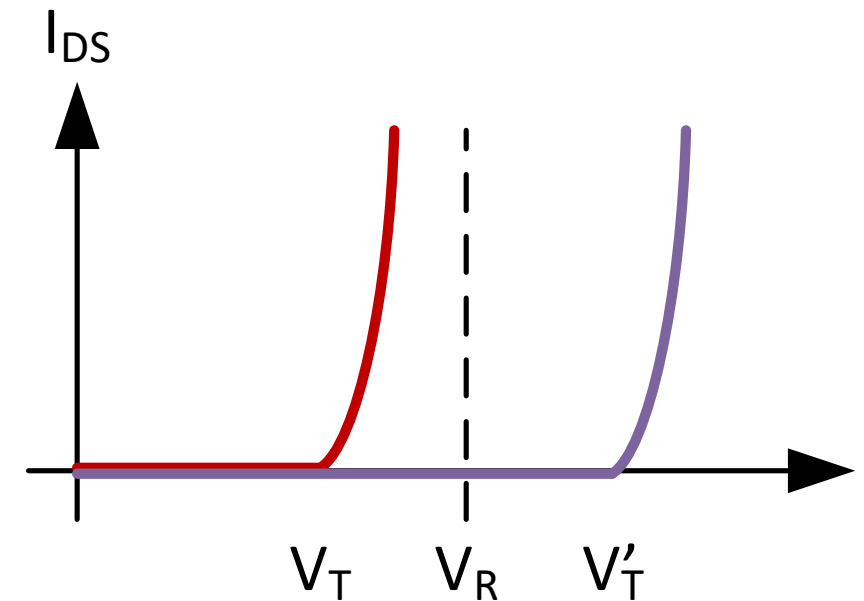
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- But before ...



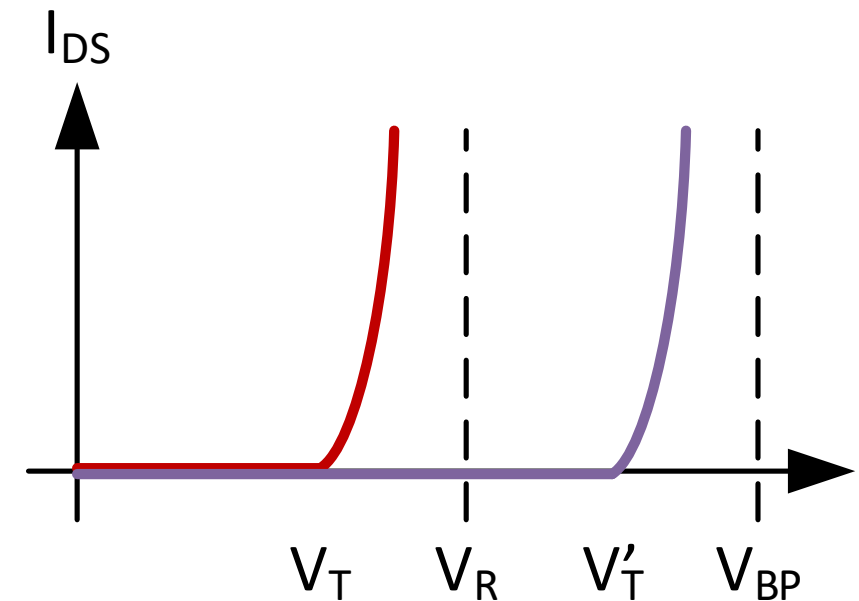
(NAND) Flash memory

- Like any other FGMOS
 - $V_T < V_R < V'_T$
 - If flash transistor not programmed (erased)
 - Transistor = ON (short circuit), when applying V_R
 - If flash transistor programmed
 - Transistor = OFF (open circuit), when applying V_R



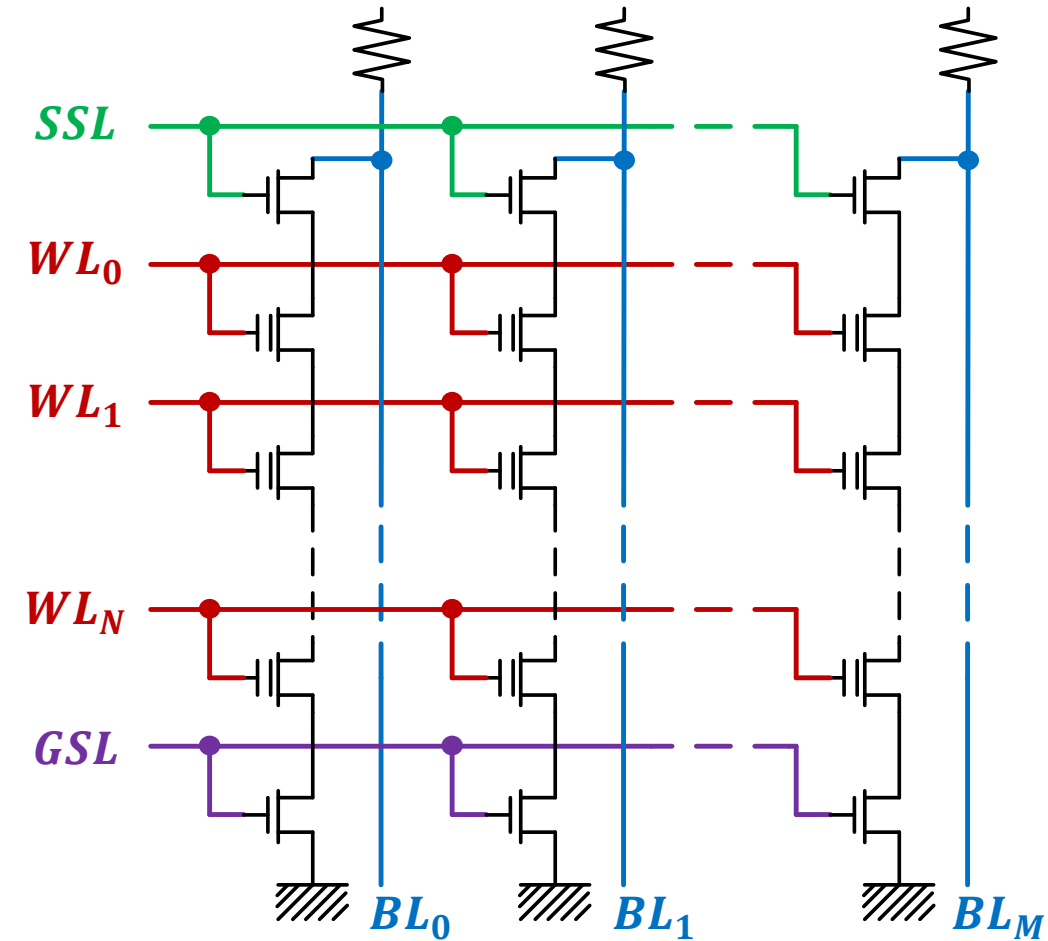
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- In addition
 - V_{BP} = **bypass** voltage
 - $V_{BP} > V'_T \rightarrow$ **transistor always ON** (short circuit)



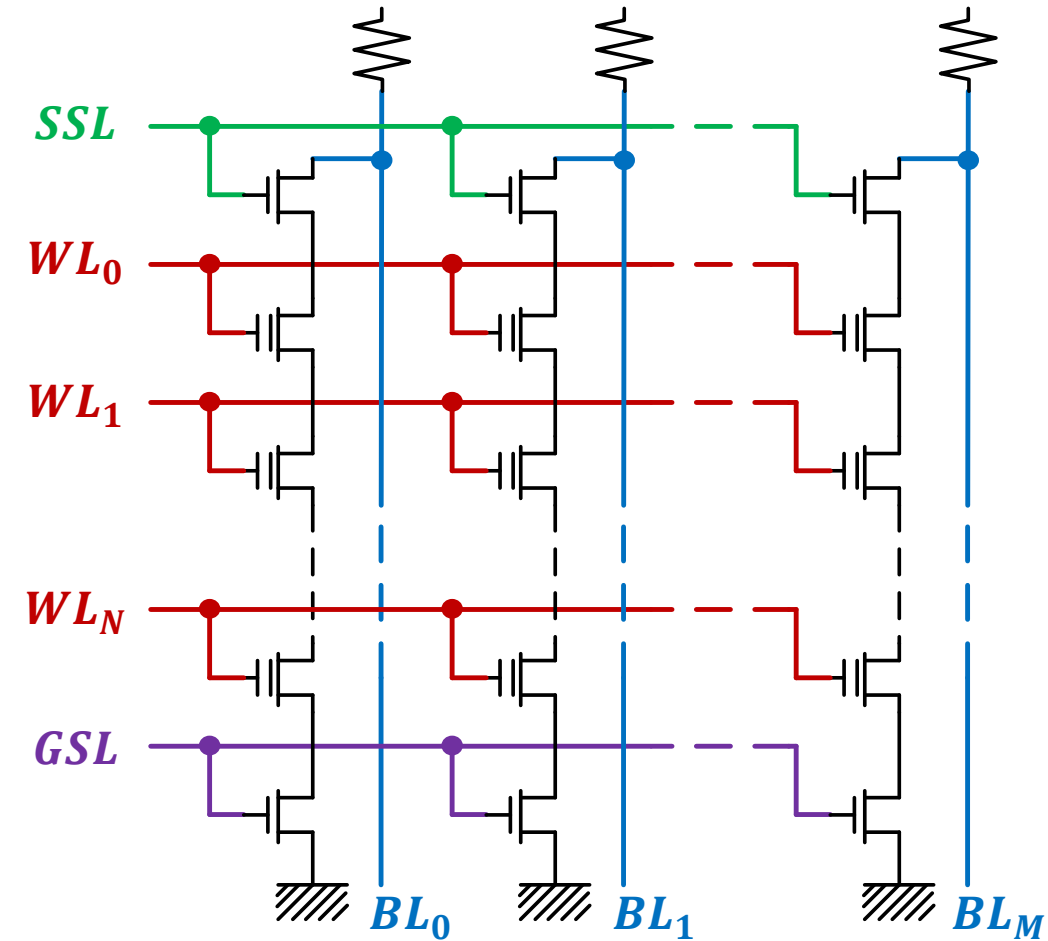
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- Working principle
 - Program by page – Example



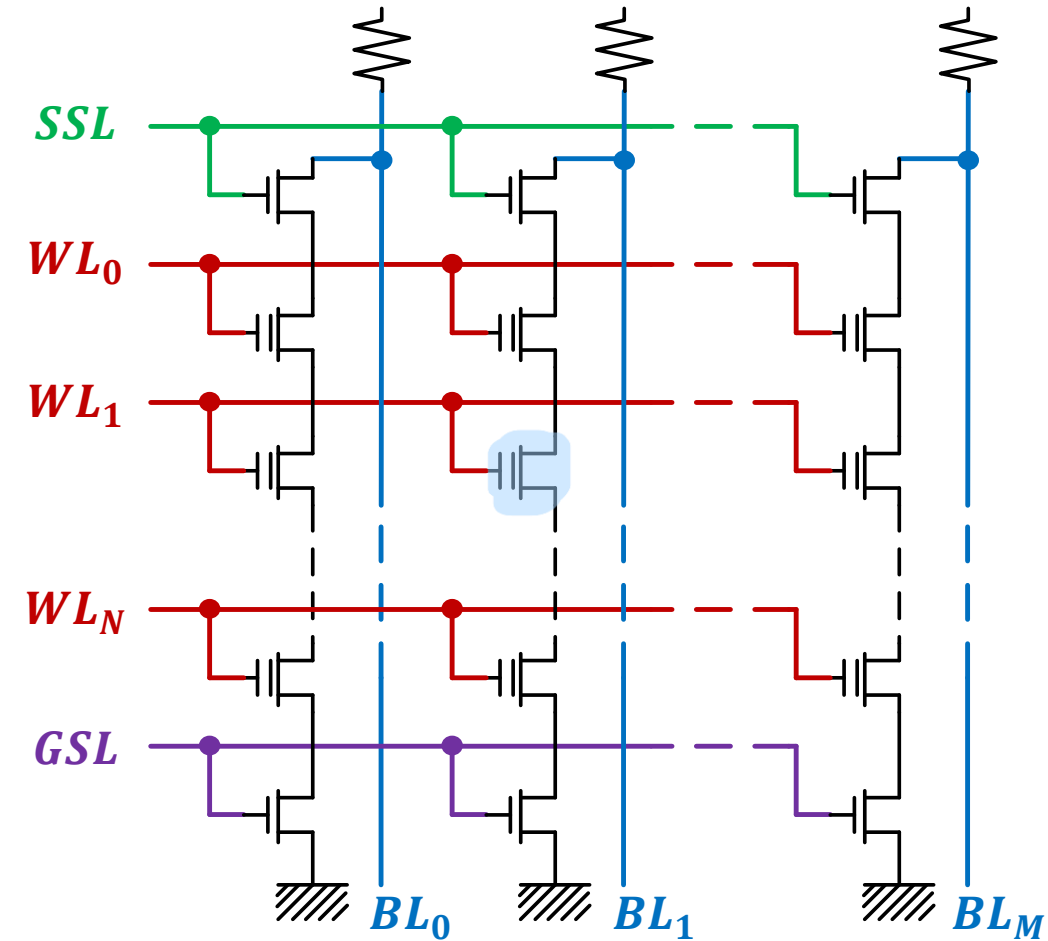
(NAND) Flash memory

- Working principle
 - Program by page – Example
 - $GSL = 0$ (0 V)
 - $SSL = 1$ (V_{CC})
 - V_{PP} on WL of cells/transistors to be programmed
 - V_{BP} on all other WL s
 - V_{PP} on BL of cells/transistors to be programmed
 - 0 on all other BL s



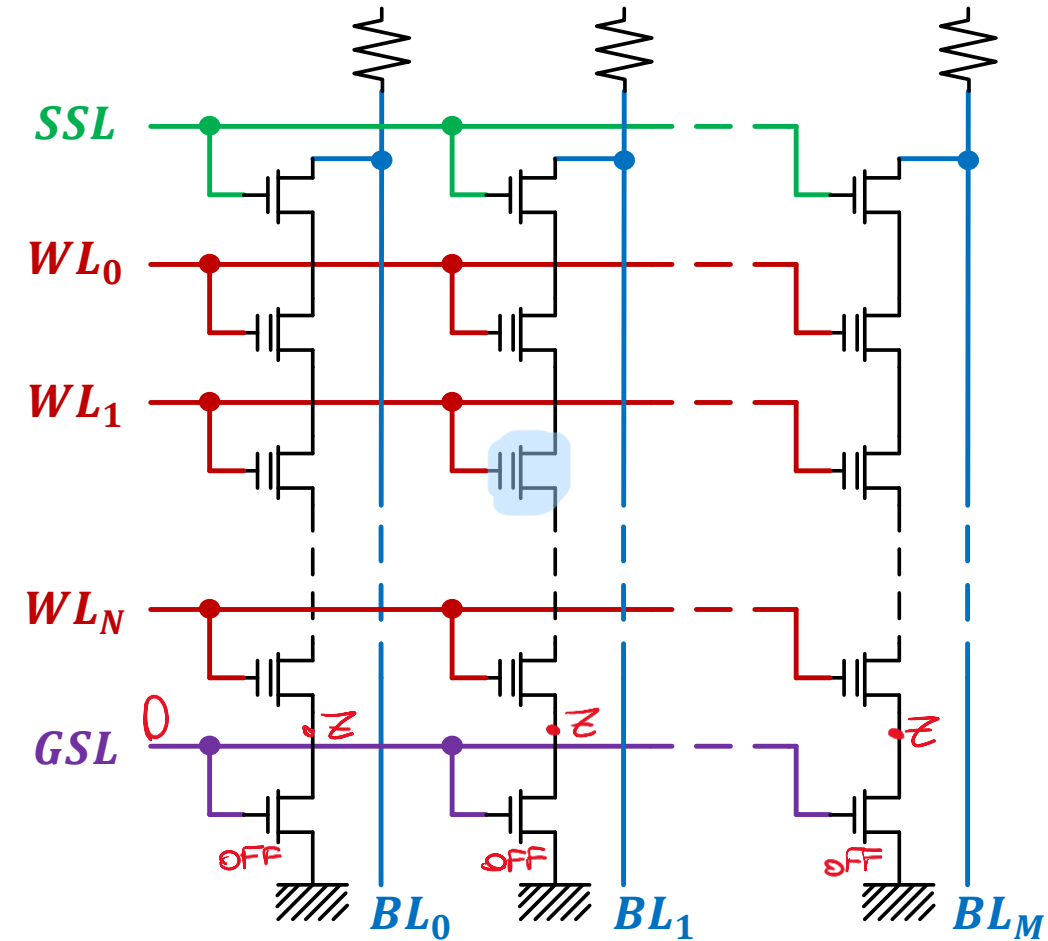
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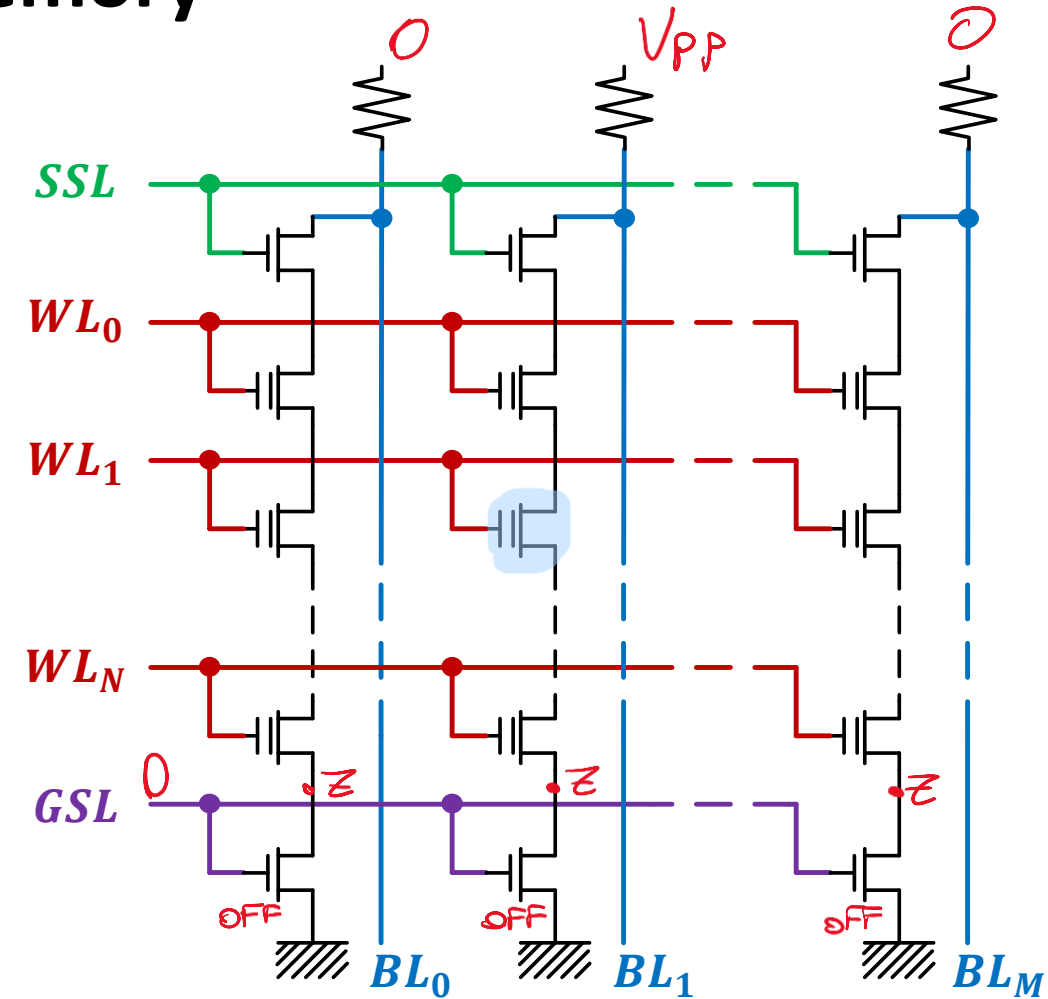
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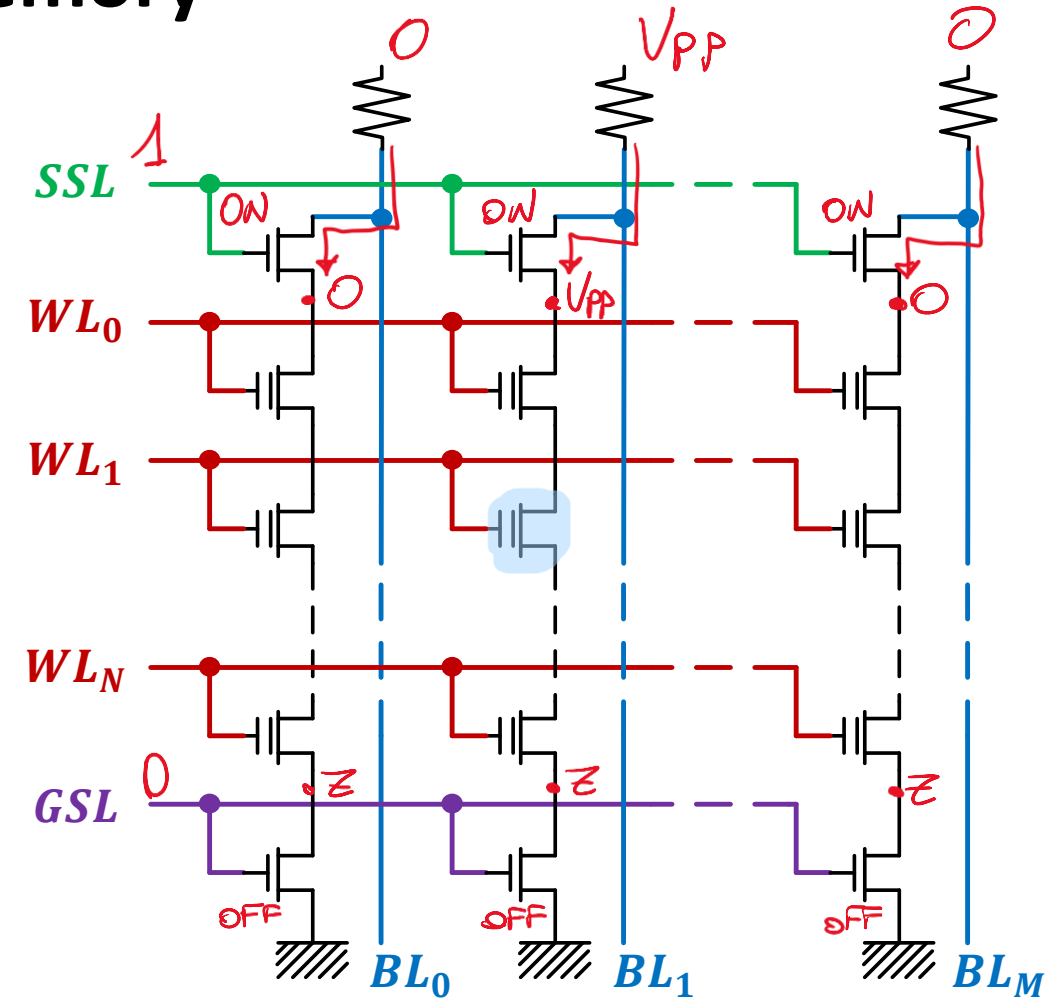
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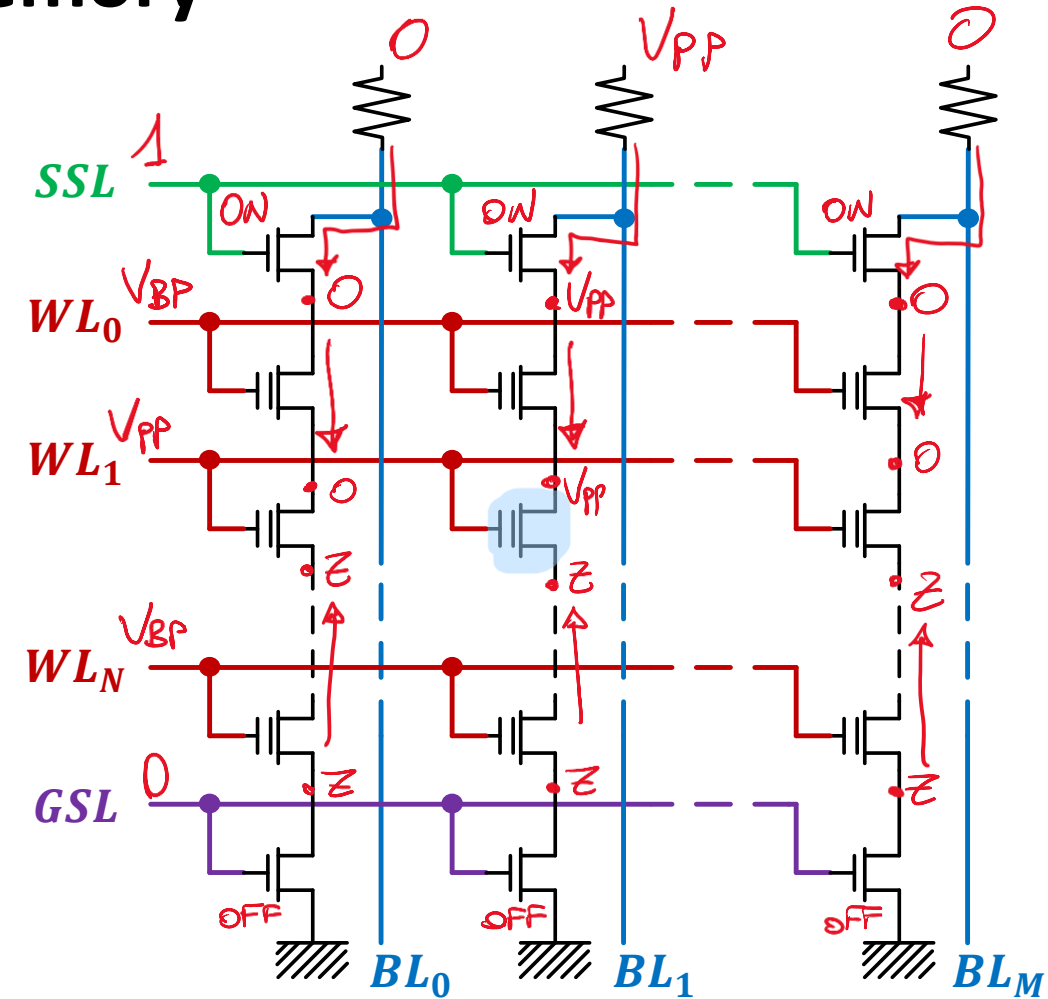
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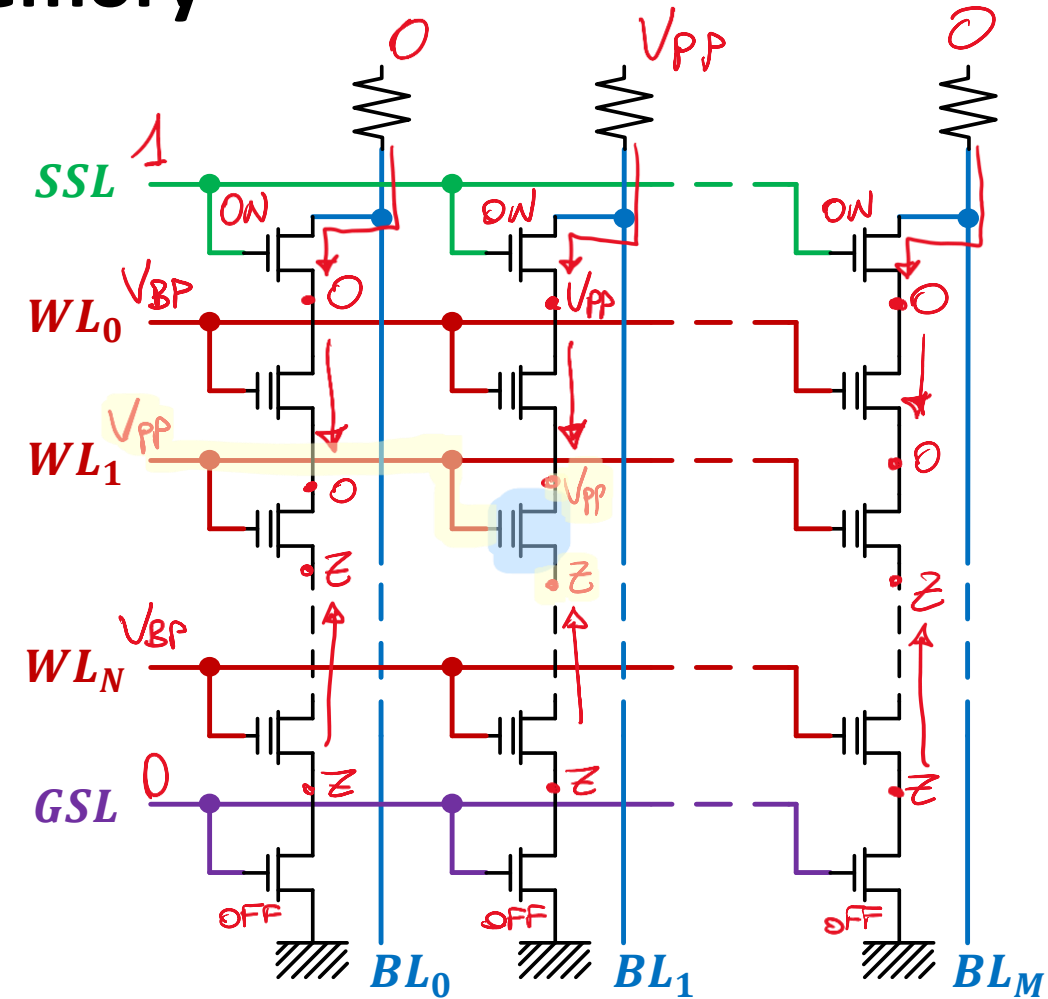
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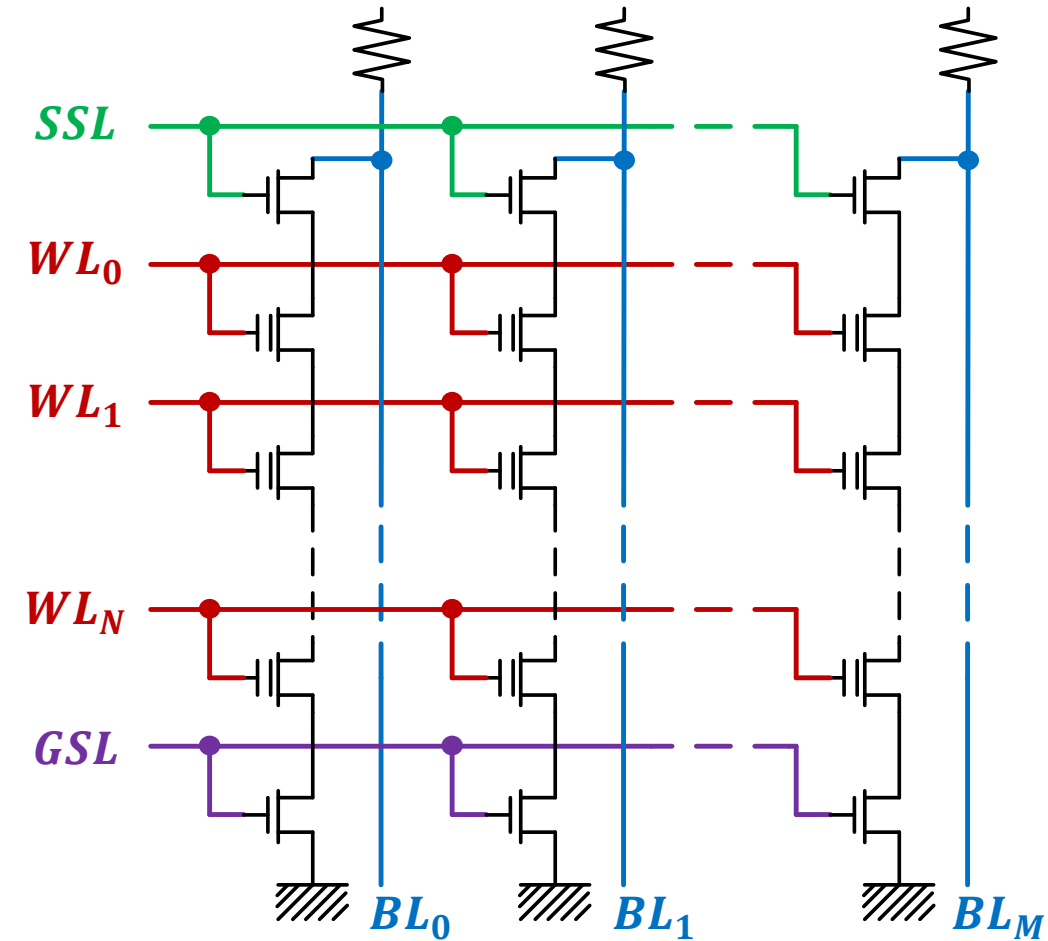
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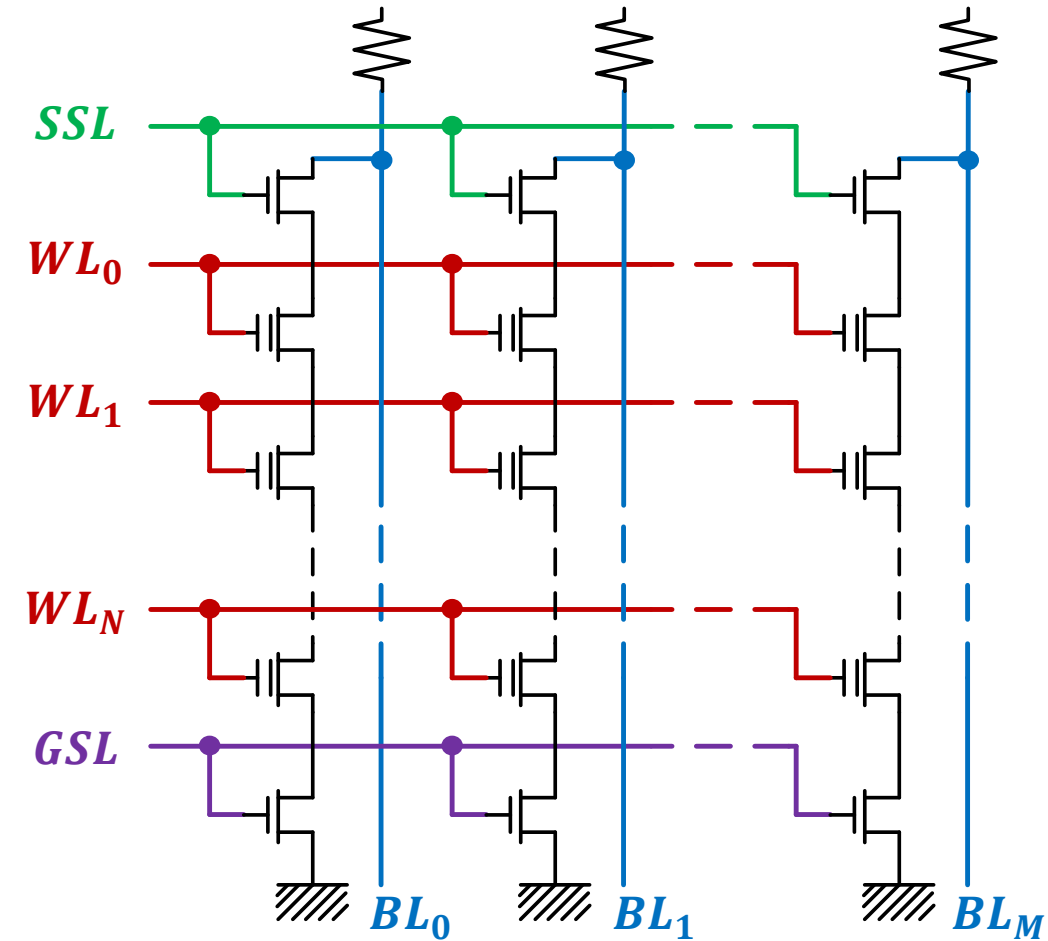
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- Working principle
 - Erase by block – Example



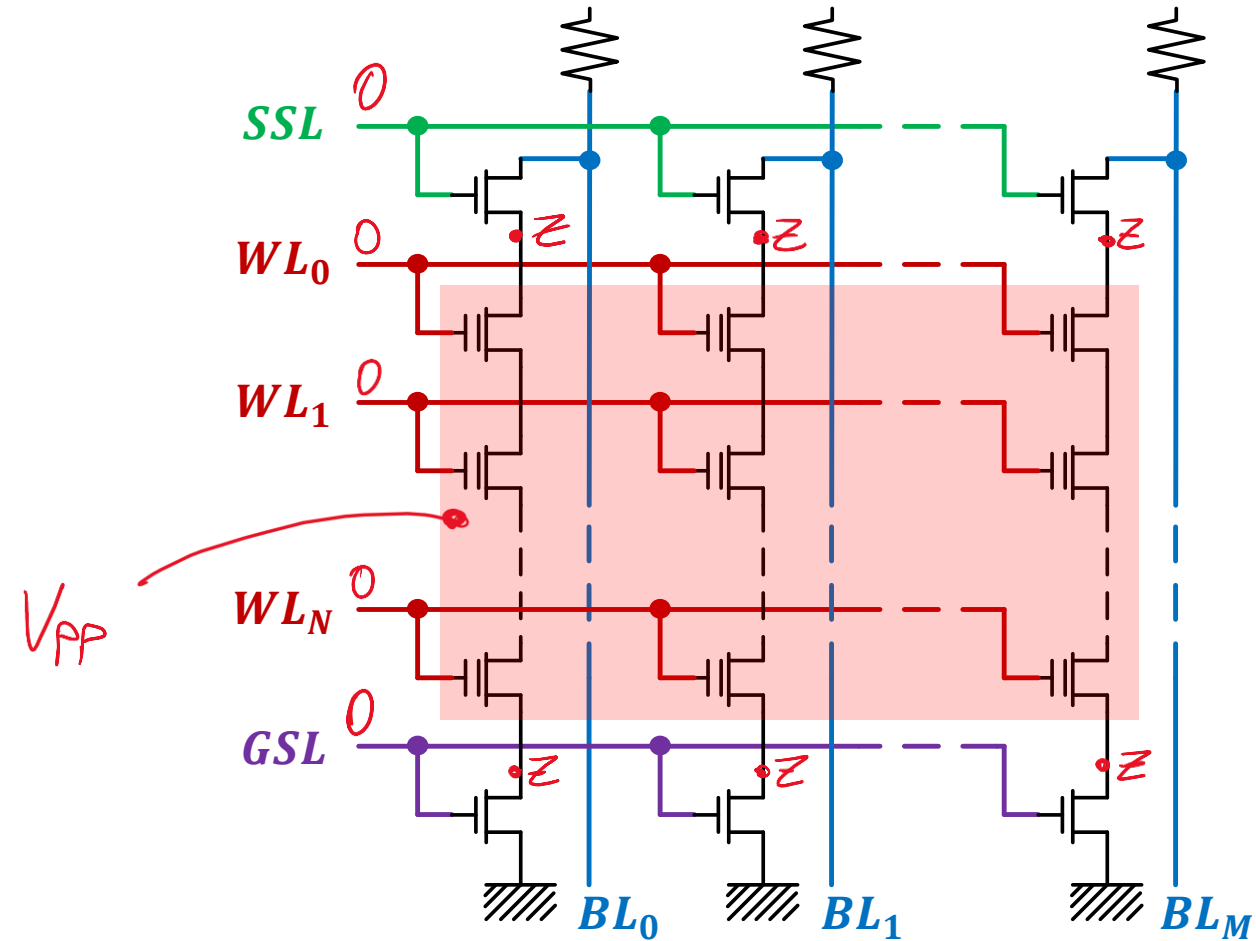
(NAND) Flash memory

- Working principle
 - Erase by block – Example
 - $GSL = 0$ (0 V)
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 - 0 on all WLs
 - V_{PP} on substrate



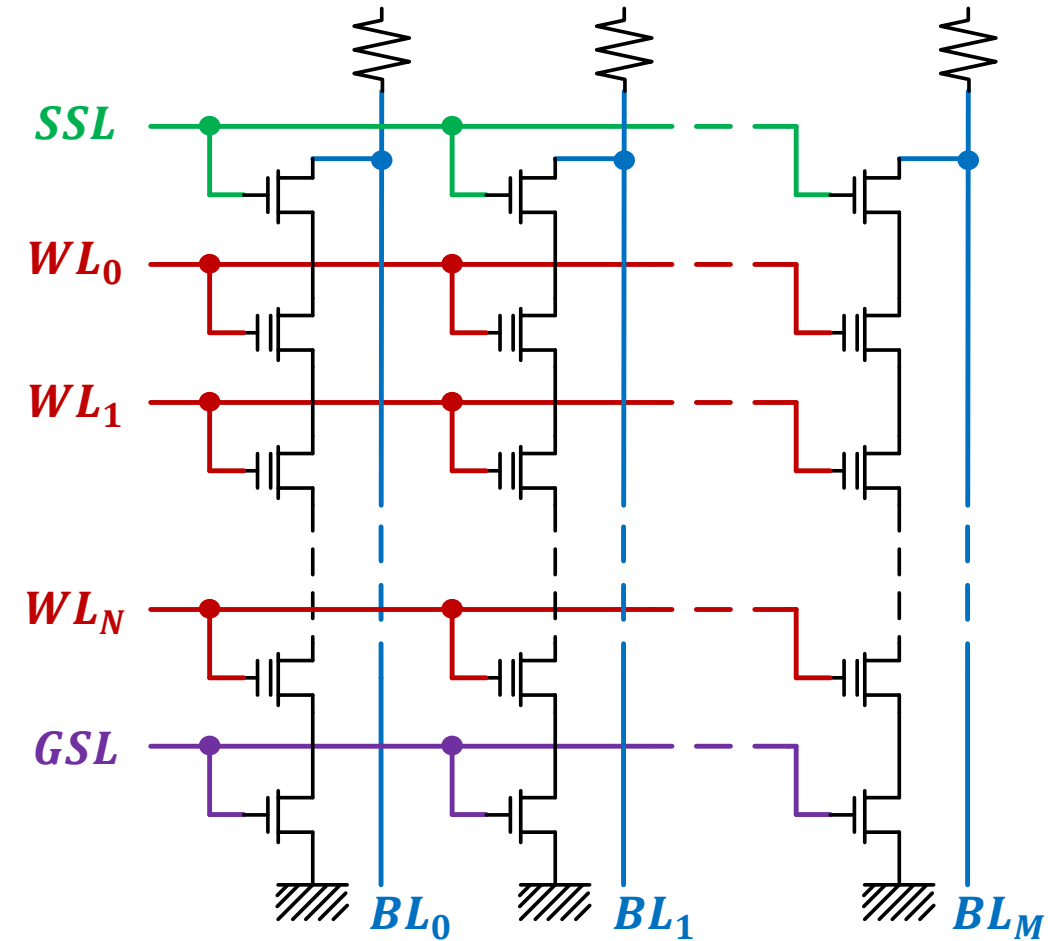
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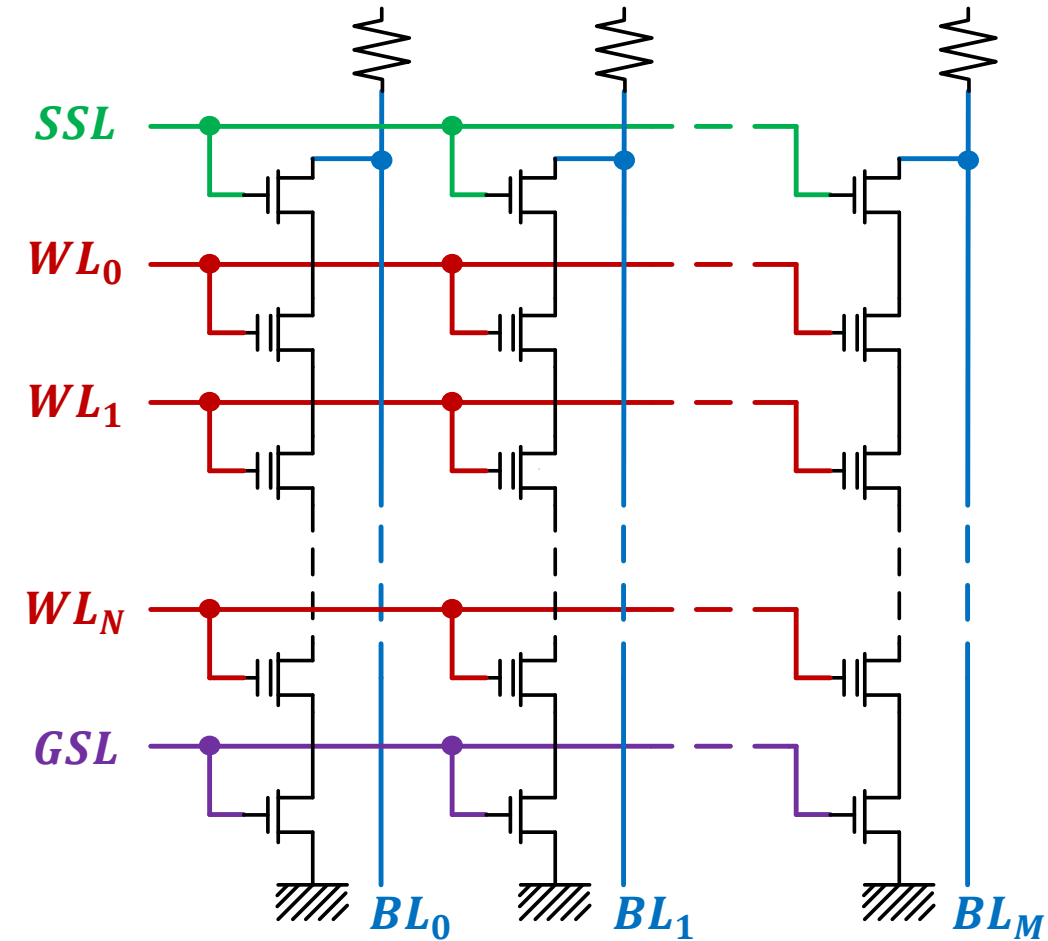
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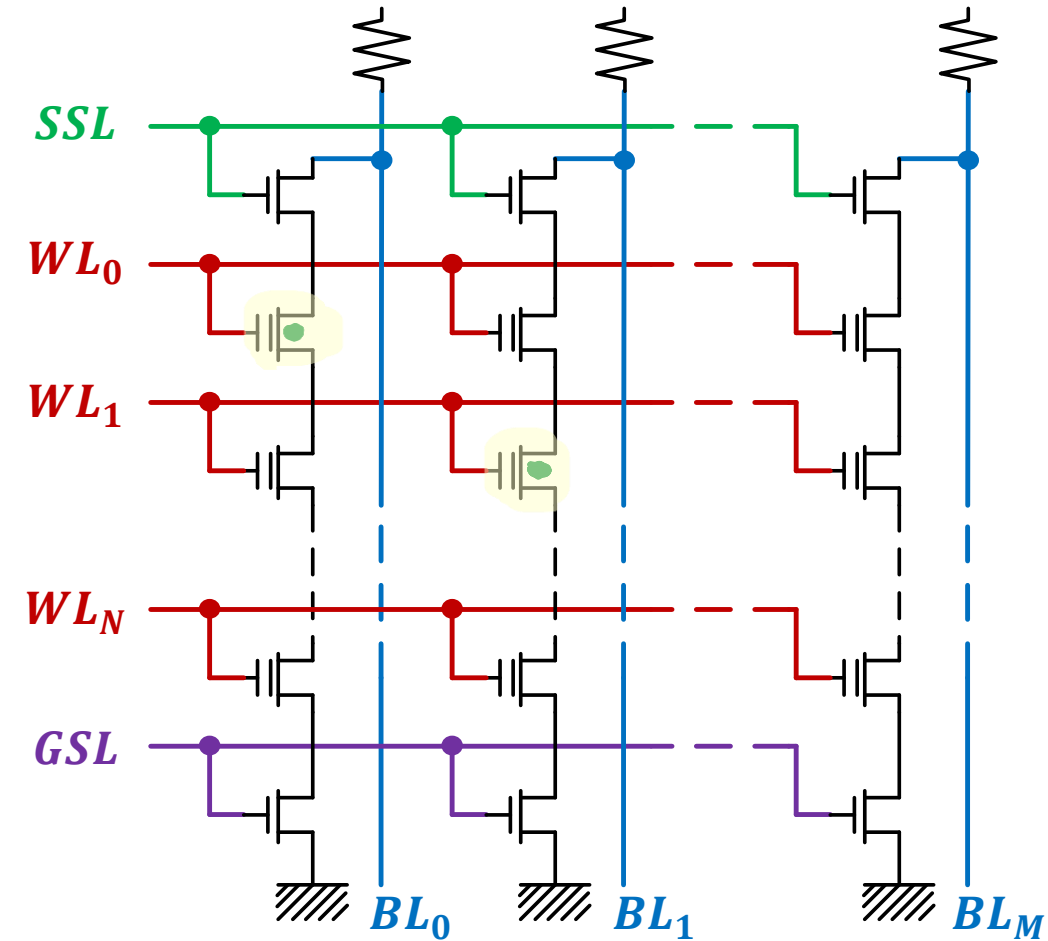
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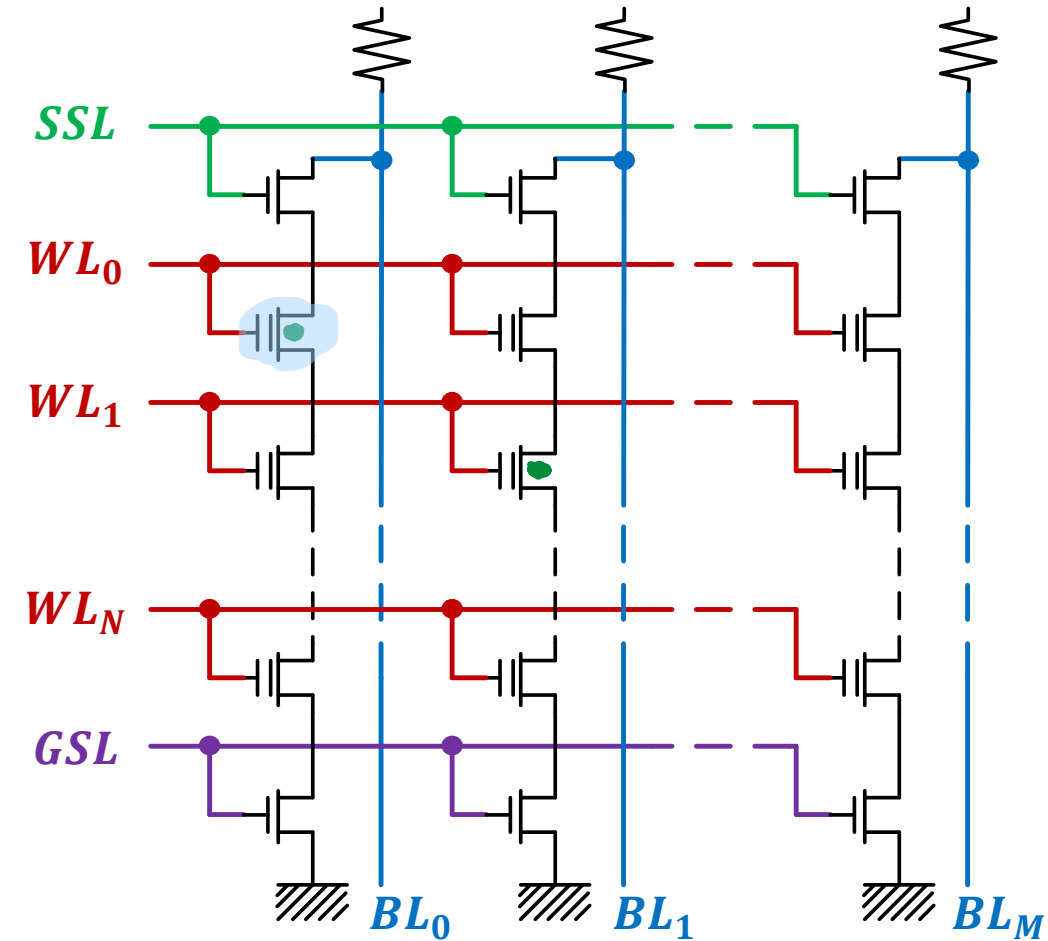
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 - All other cells are not programmed



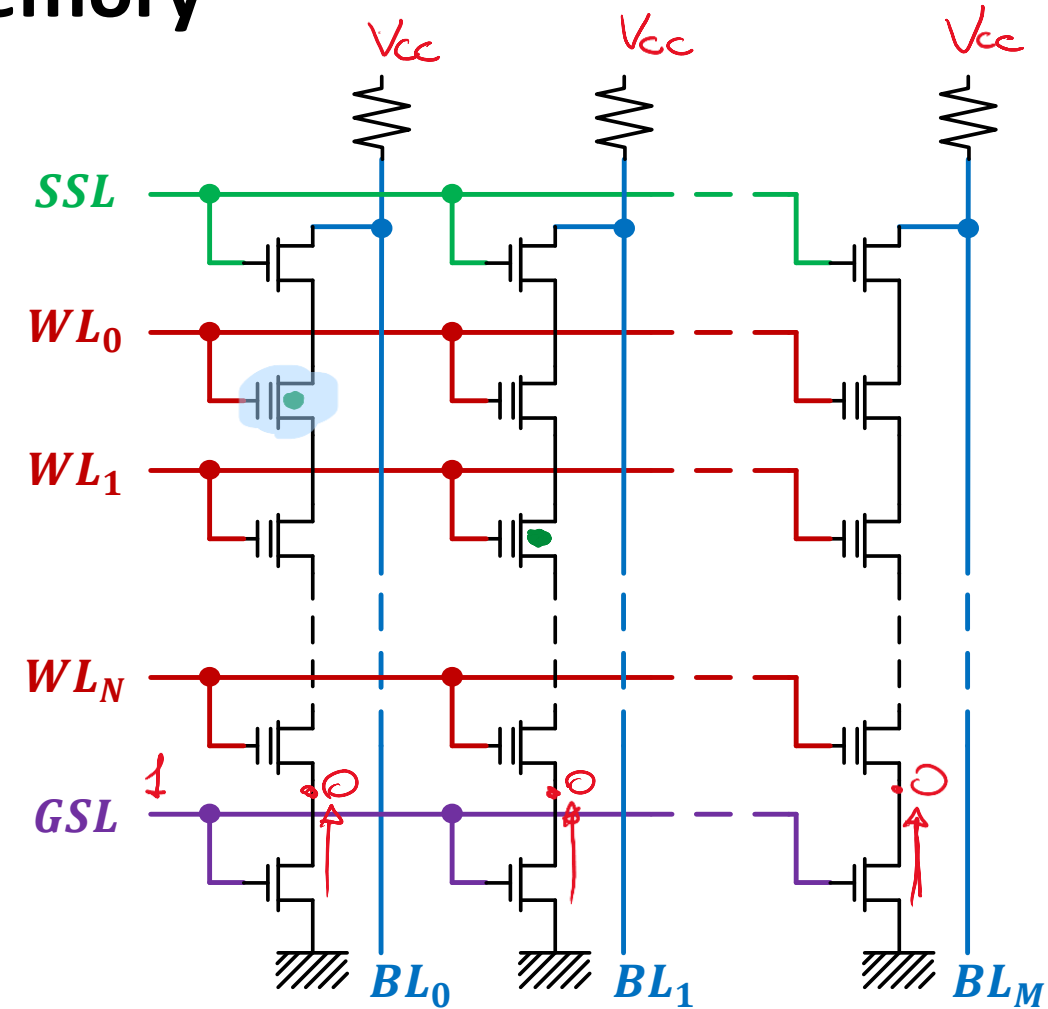
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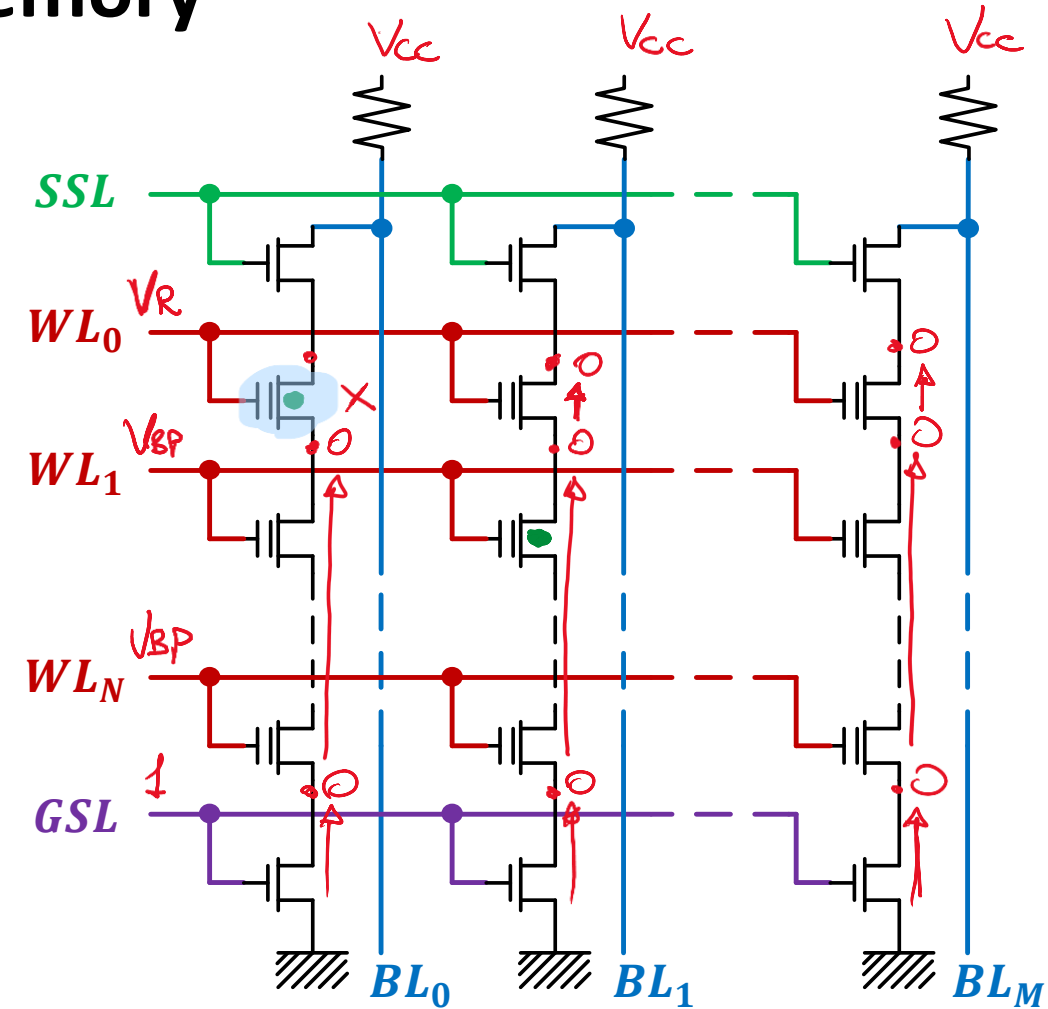
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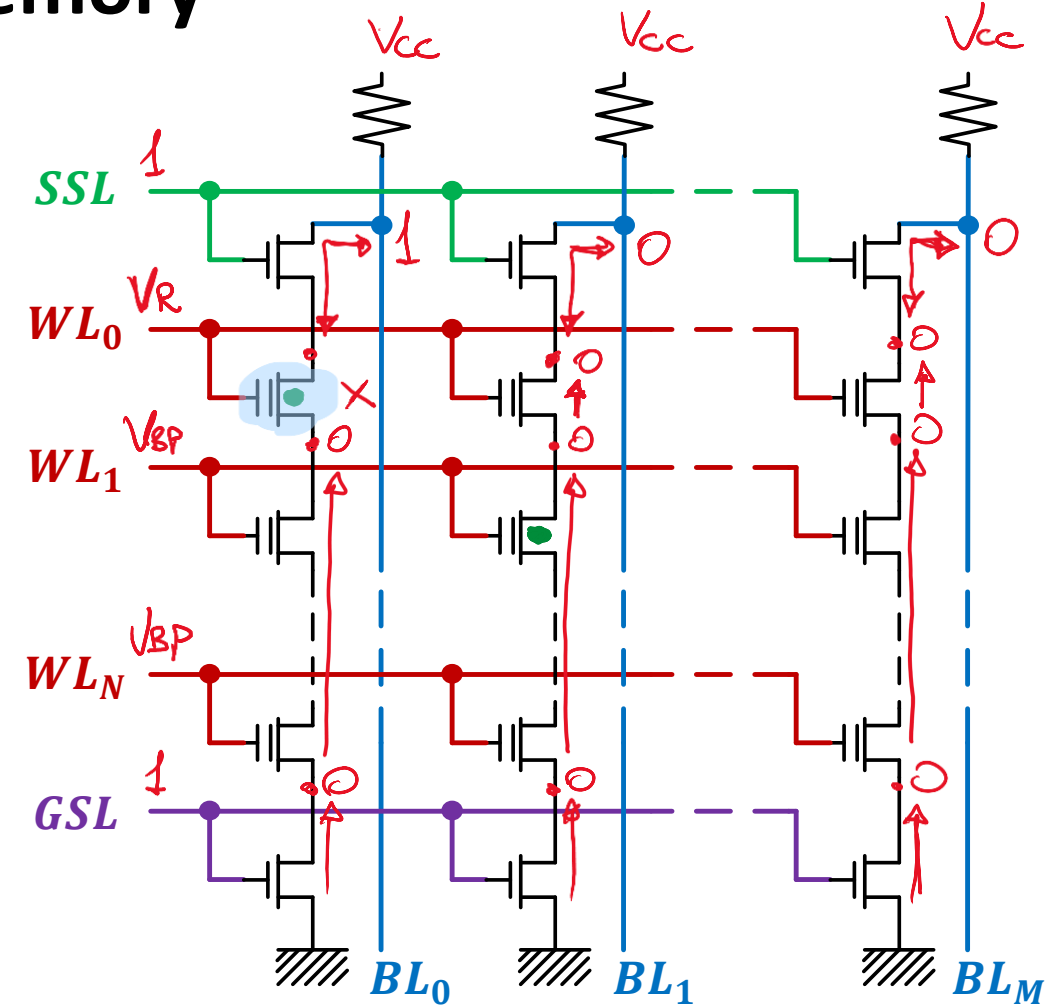
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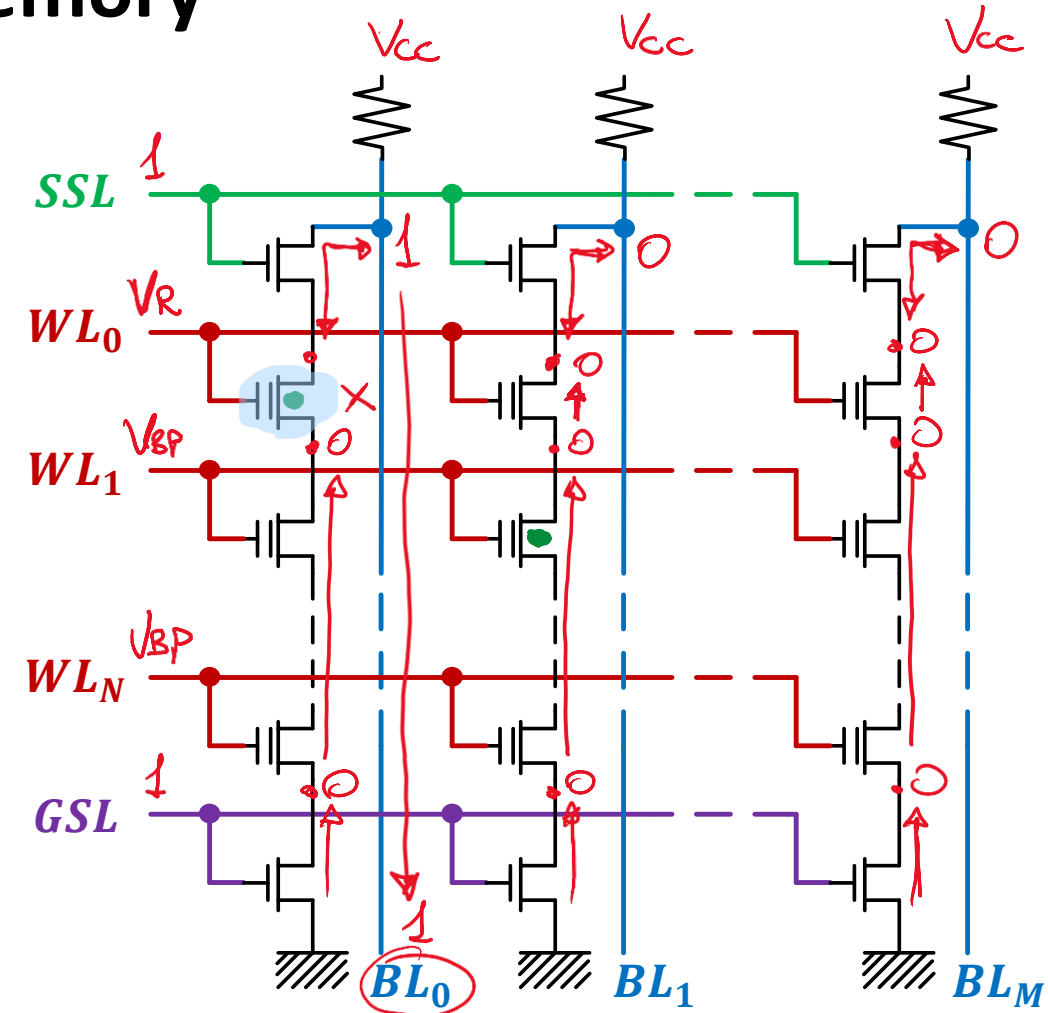
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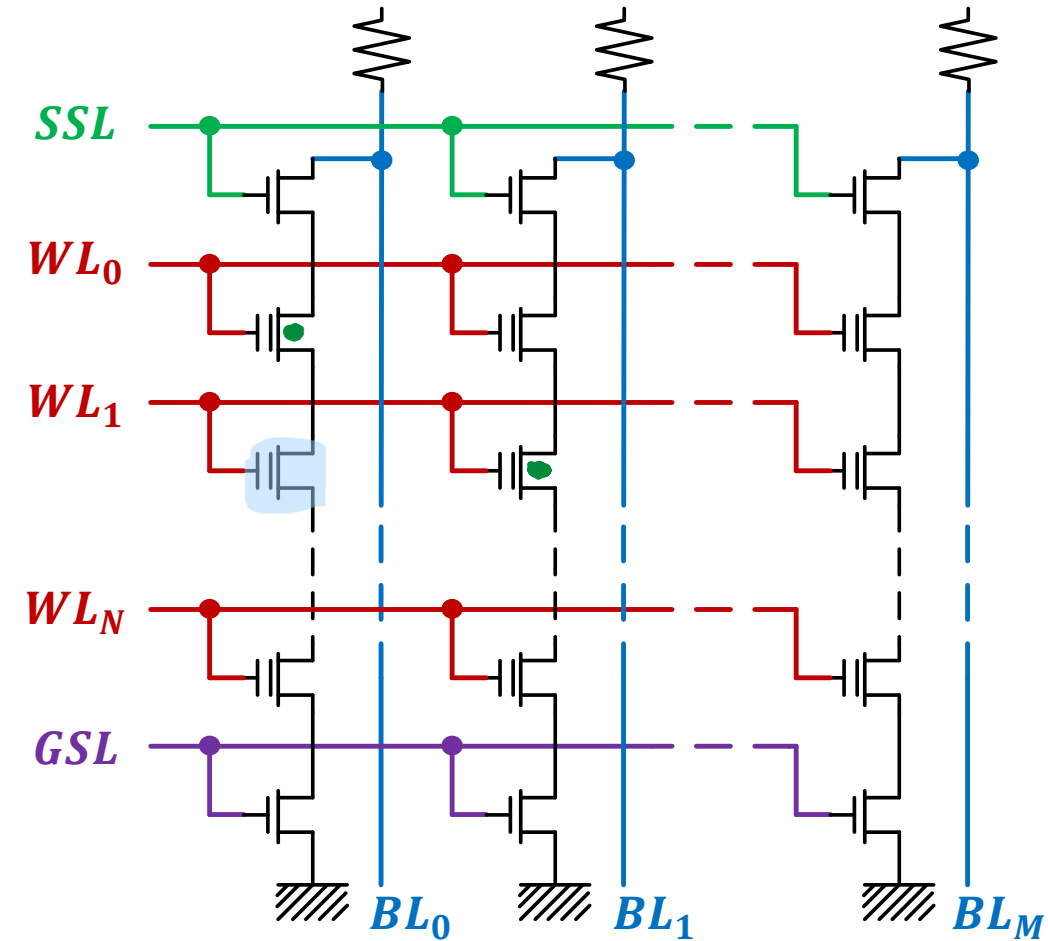
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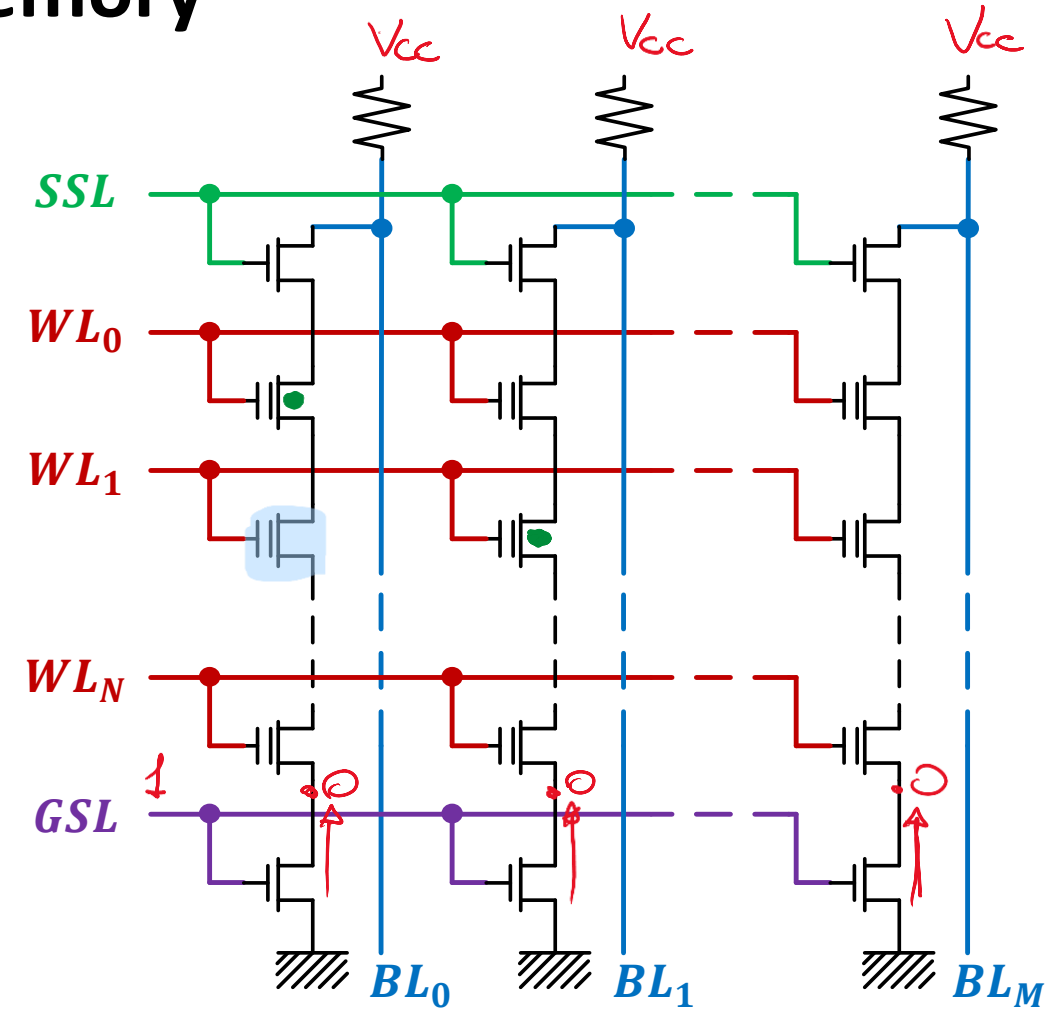
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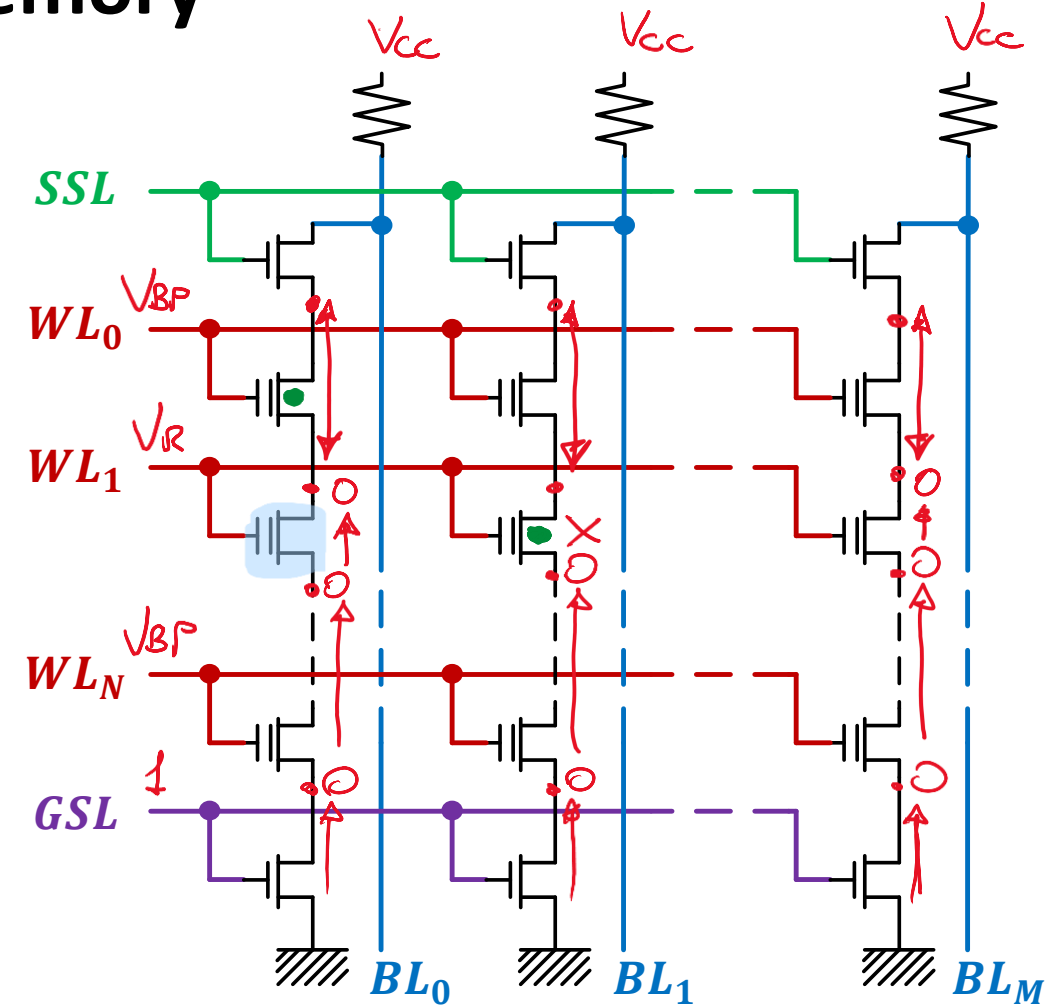
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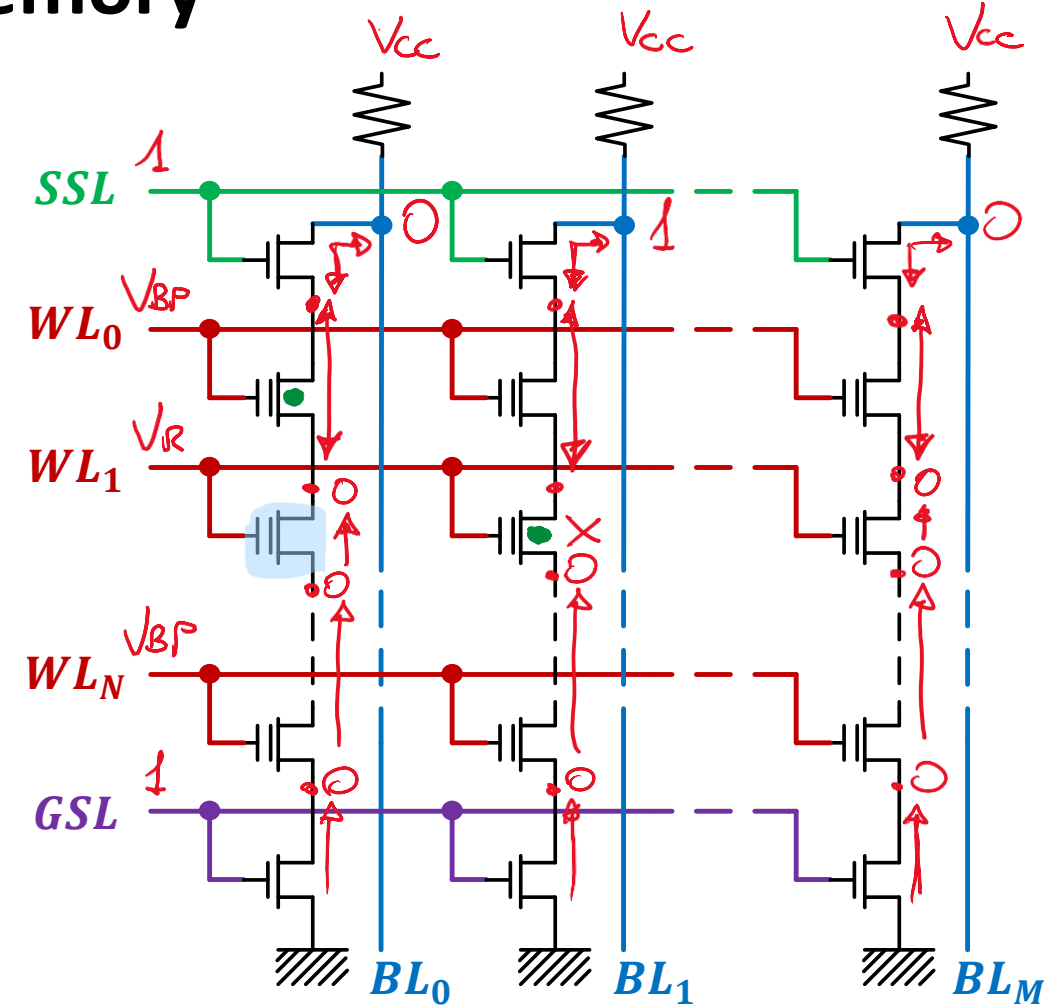
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 - V_R on WL of cells/transistors to be read
 - V_{BP} on all other WL s
 - V_{CC} on all BL s
 - Assume cells (0,0) and (1,1) are programmed
 - All other cells are not programmed
 - Let's assume to read cell (1,0)



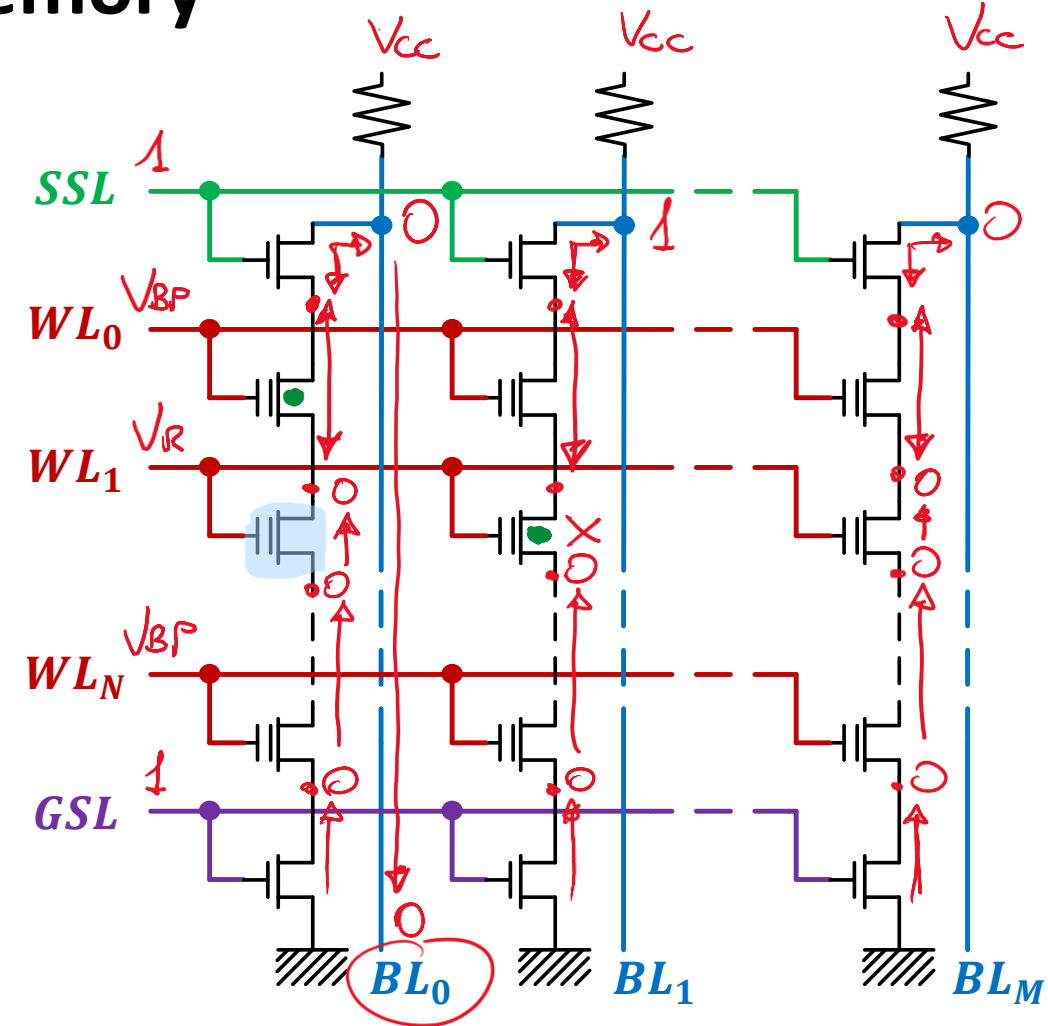
(NAND) Flash memory

- Working principle
 - Read by page – Example
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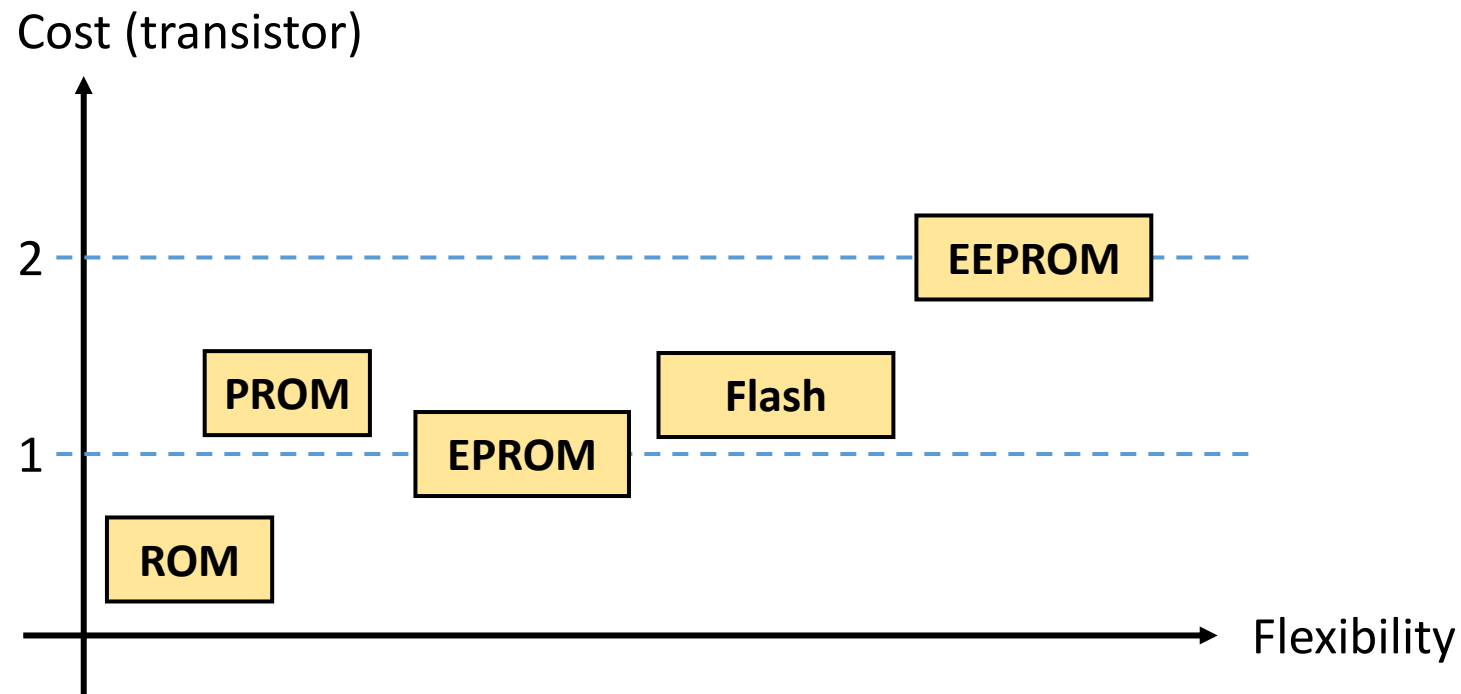


(NAND) Flash memory – Final remarks

- More than one block in a memory
 - Not just one!
- Data overwriting is not possible
- For each data write (in a block)
 - Erasing (the whole block)
 - Programming the block by page (one word line at a time)

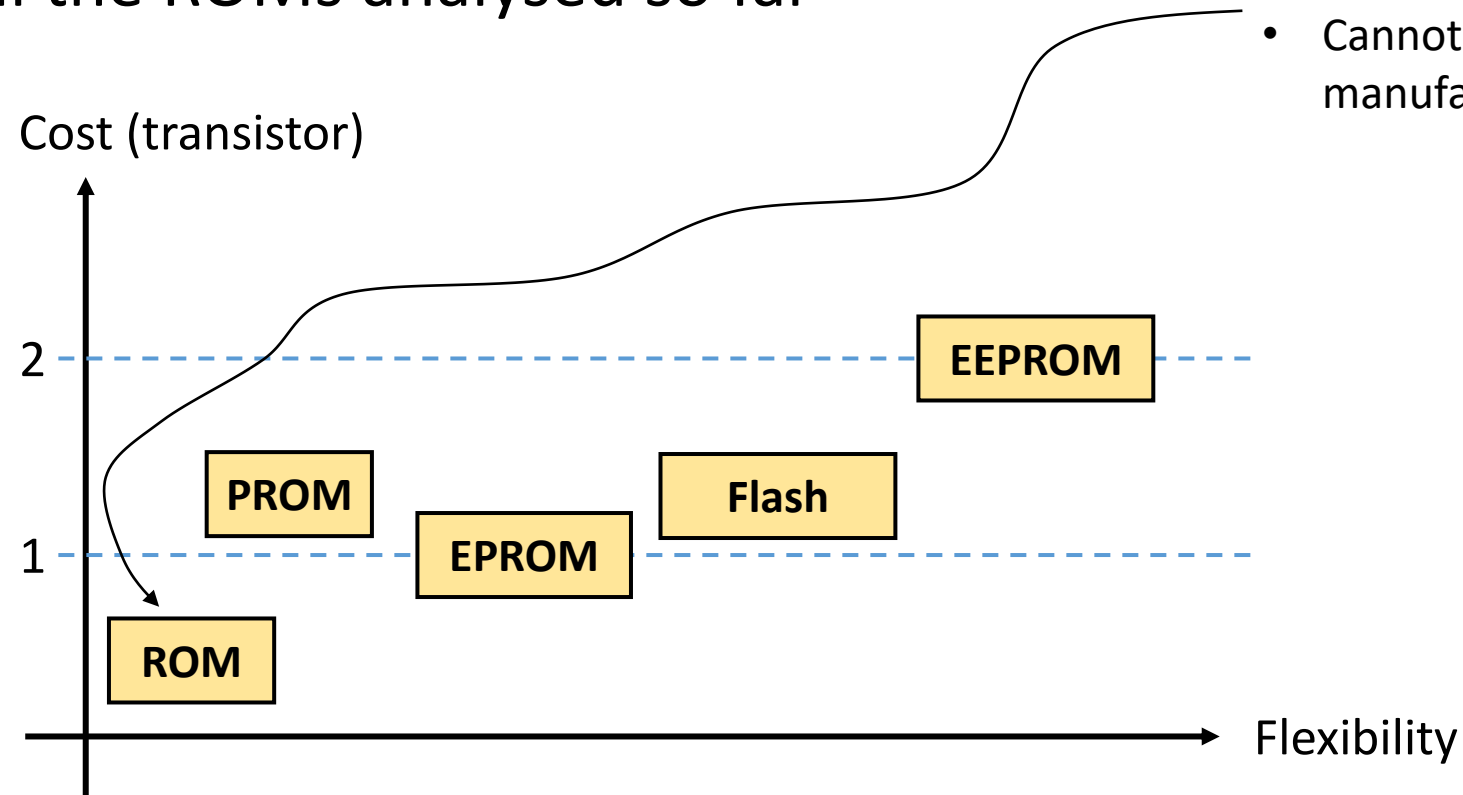
ROMs summary and comparison

- Comparing all the ROMs analysed so far



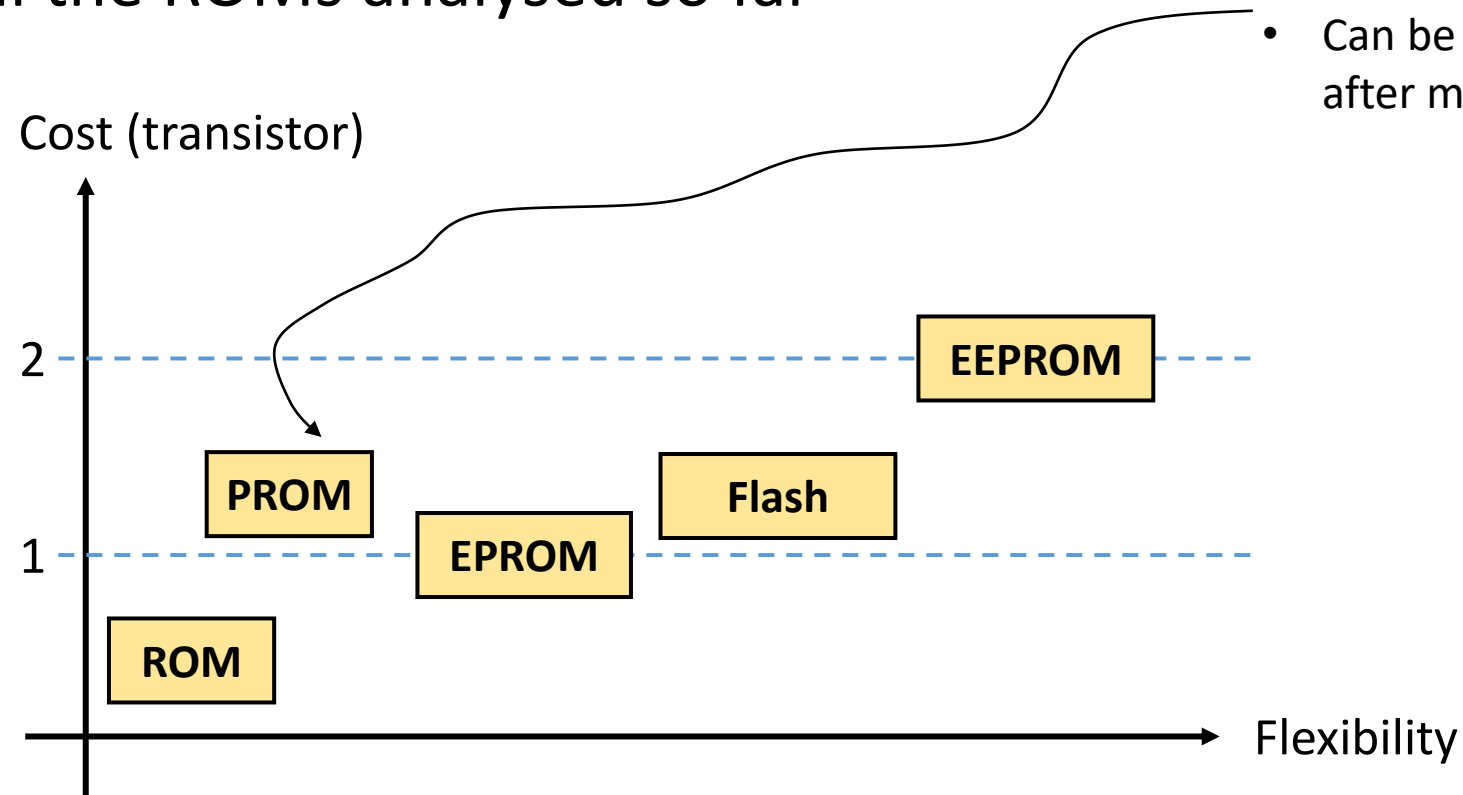
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ROMs summary and comparison

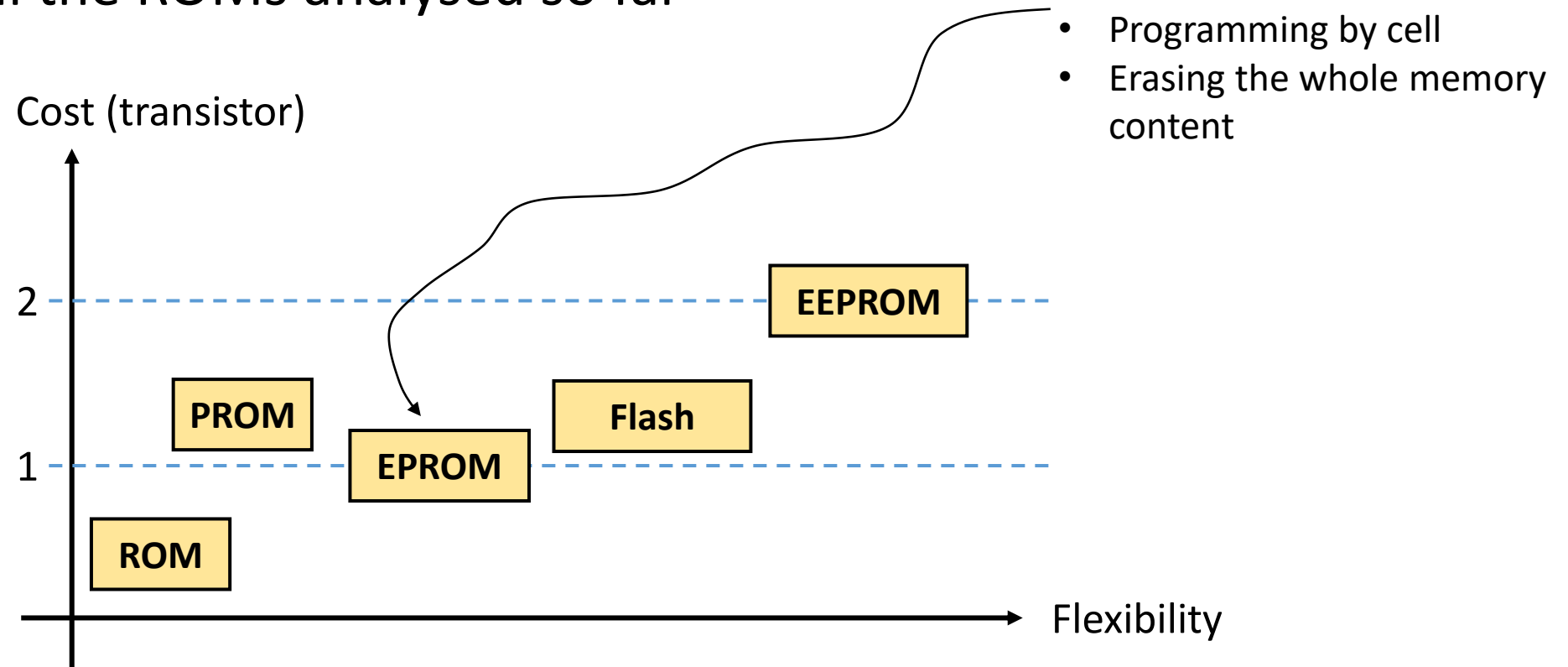
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- Each cell: 1 transistor + 1 fuse
- Can be modified just one time after manufacturing

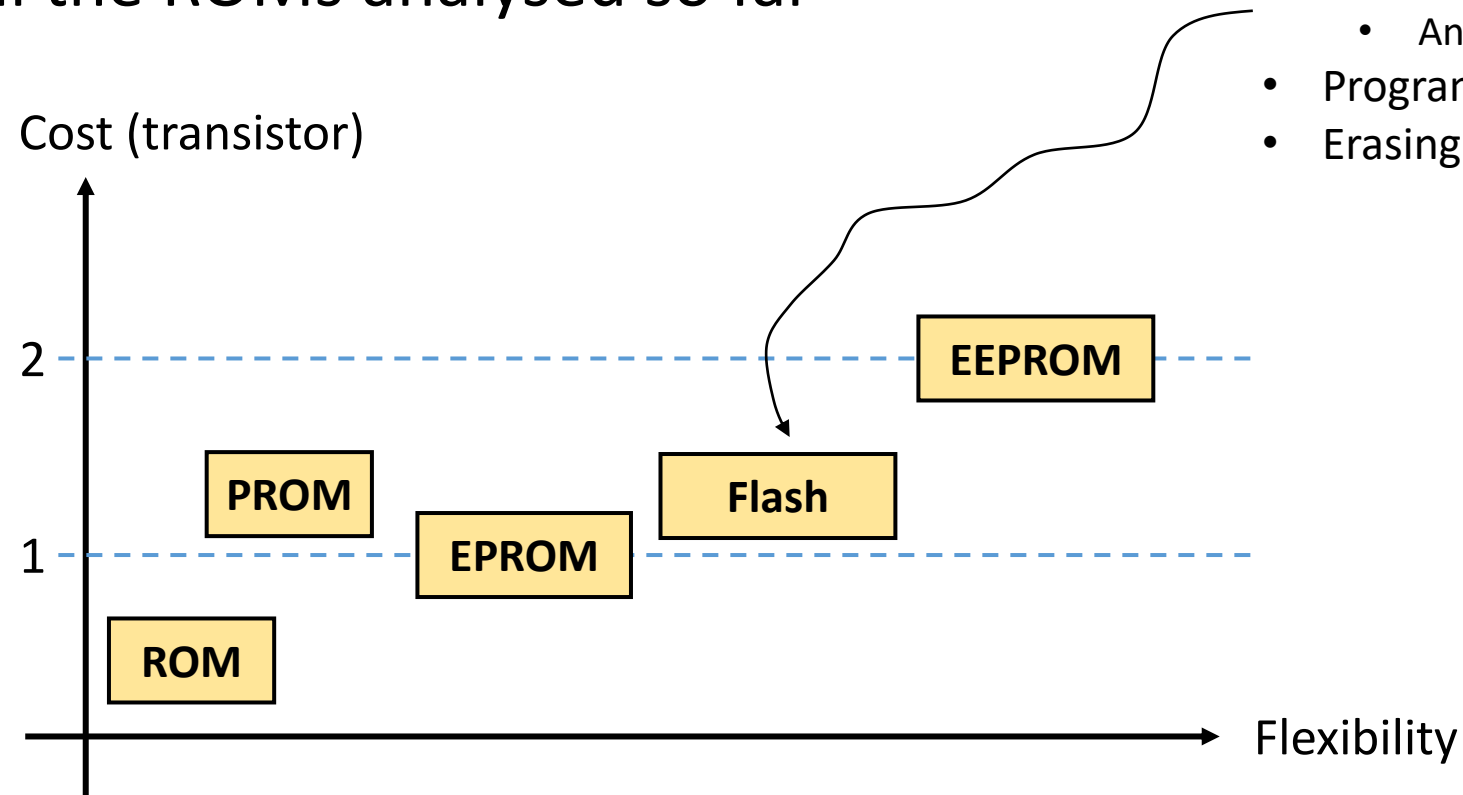
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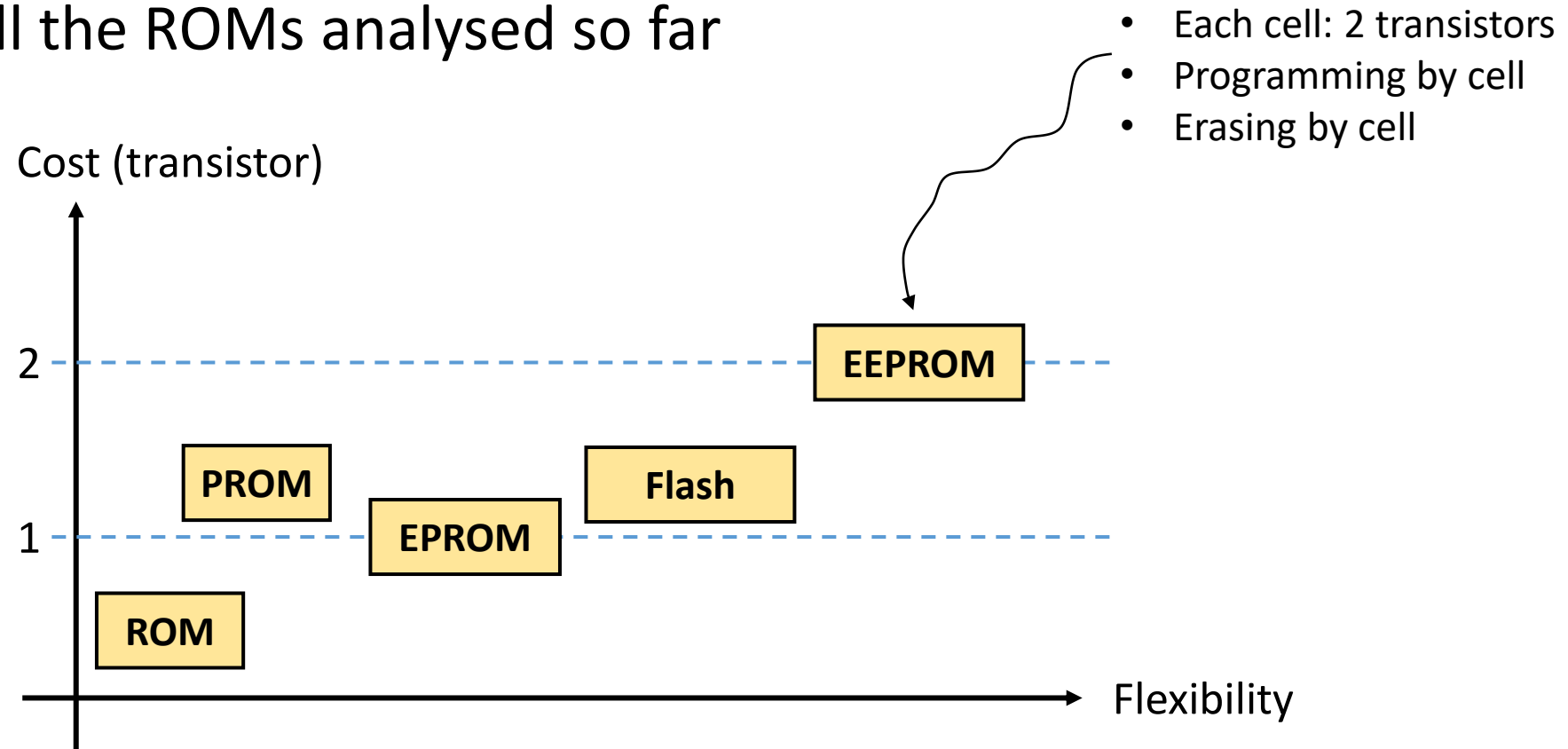
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Thank you for your attention

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